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LM4935 Boomer[®] Audio Power Amplifier Series Audio Sub-System with Dual-Mode Stereo Headphone & Mono High Efficiency Loudspeaker Amplifiers and Multi-Purpose ADC

1.0 General Description

The LM4935 is an integrated audio subsystem that supports both analog and digital audio functions. The LM4935 includes a high quality stereo DAC, a mono ADC, a multipurpose SAR ADC, a stereo headphone amplifier, which supports output cap-less (OCL) or AC-coupled (SE)modes of operation, a mono earpiece amplifier and a mono high efficiency loudspeaker amplifier. It is designed for demanding applications in mobile phones and other portable devices.

The LM4935 features a bi-directional I²S serial interface for full range audio and an I²C or SPI compatible interface for control. The stereo DAC path features an SNR of 88 dB with an 18-bit 48 kHz input. In SE mode the headphone amplifier delivers at least 33 mW_{BMS} to a 32Ω single-ended stereo load with less than 1% distortion (THD+N) when $A_V_{\rm DD}$ = 3.3V. The mono earpiece amplifier delivers at least 115 mW_{BMS} to a 32 $\!\Omega$ bridged-tied load with less than 1% distortion (THD+N) when A_V_{DD} = 3.3V. The mono speaker amplifier delivers up to 600 mW into an 8Ω load with less than 1% distortion when $LS_{DD} = 3.3V$ and up to 1.3W when LS_V_{DD} = 5.0V. The LM4935 also contains a general purpose SAR ADC for housekeeping duties such as battery and temperature monitoring. This can also be used for analog volume control of the output stages and can trigger interrupt events.

The LM4935 employs advanced techniques to reduce power consumption, to reduce controller overhead to speed development time and to eliminate click and pop. Boomer audio power amplifiers were designed specifically to provide high guality output power with a minimal amount of external components. It is therefore ideally suited for mobile phone and other low voltage applications where minimal power consumption, PCB area and cost are primary requirements.

2.0 Applications

- Smartphones
- Mobile Phones and Multimedia Terminals
- PDAs, Internet Appliances and Portable Gaming
- Portable DVD/CD/AAC/MP3 Players
- Digital Cameras/Camcorders

3.0 Key Specifications

- P_{HP (AC-COUP)} @ A_V_{DD} = 3.3V, 32Ω, 1% THD 33 mW
- P_{HP (OCL)} @ A_V_{DD} = 3.3V, 32Ω, 1% THD 31 mW 1.3 W
- P_{LS} @ LS_V_{DD} = 5V, 8Ω, 1% THD
- P_{LS} @ LS_V_{DD} = 4.2V, 8Ω, 1% THD 900 mW 600 mW
- P_{LS} @ LS_V_{DD} = 3.3V, 8Ω, 1% THD

- Supply Voltage Range $BB_V_{DD} = 1.8V$ to 4.5V, $D_V_{DD} \& PLL_V_{DD} = 2.7V$ to 4.5V $LS_V_{DD} \& A_V_{DD} = 2.7V$ to 5.5V
- Shutdown Current 1.1 µA
- PSRR @ 217 Hz, A_V_{DD} = 3.3V, (Headphone) 60 dB
- SNR (Stereo DAC to AUXOUT) 88 dB (typ)
- SNR (Mono ADC from Cell Phone In) 90 dB (typ)
- SNR (Aux In to Headphones) 98 dB (typ)

4.0 Features

- 18-bit stereo DAC
- 16-bit mono ADC
- 12-bit 4 input multipurpose SAR ADC
- 8 kHz to 48 kHz stereo audio playback
- 8 kHz to 48 kHz mono recording
- 1 Hz to 13.888 kHz sample rate on all 4 SAR channels
- Bidirectional PCM/I²S compatible audio interface Sigma-Delta PLL for operation from any clock at any sample rate
- Low power clock network operation if 12 MHz system clock is available
- Read/write I²C or SPI compatible control interface
- 33mW stereo headphone amplifier at 3.3V
- OCL or AC-coupled headphone operation
- Automatic headphone & microphone detection
- Support for internal and external microphones
- Automatic gain control for microphone input
- High efficiency BTL 8Ω amplifier, 600 mW @ 3.3V
- 115 mW earpiece amplifier at 3.3V
- Differential audio I/O for external cellphone module
- Mono differential auxiliary output
- Stereo auxiliary inputs
- Differential microphone input for internal microphone
- Flexible audio routing from input to output
- 32 Step volume control for mixers with 1.5 dB steps
- 16 Step volume control for microphone in 2 dB steps
- Programmable sidetone attenuation in 3 dB steps
- DC Volume Control
- Two configurable GPIO ports
- Programmable voltage triggers on SAR channels
- Multi-function IRQ output
- Micro-power shutdown mode
- Available in the 4 x 4 mm 49 bump micro SMDxt package

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LM4935

5.0 LM4935 Overview

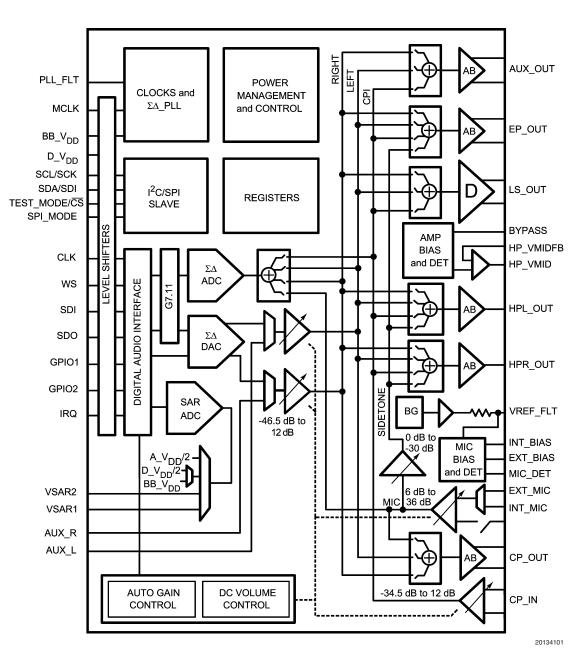


FIGURE 1. Conceptual Schematic

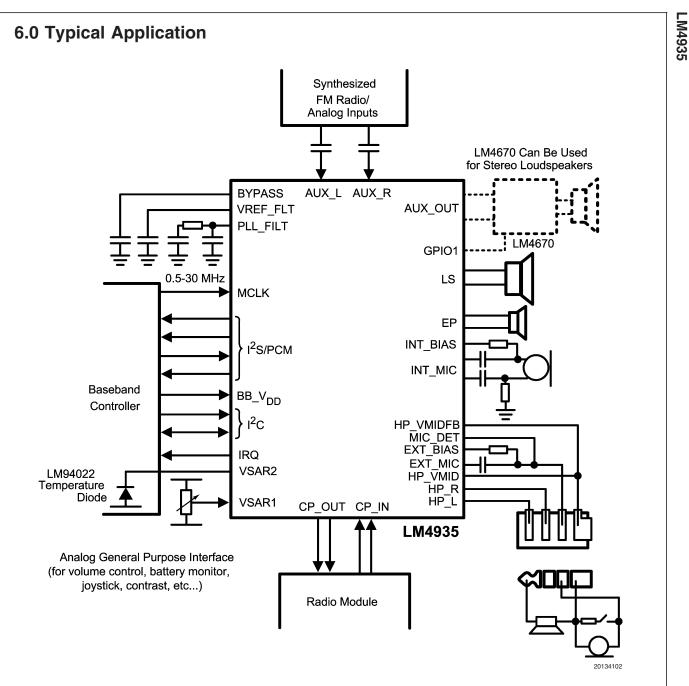


FIGURE 2. Example Application in Multimedia Mobile Phone

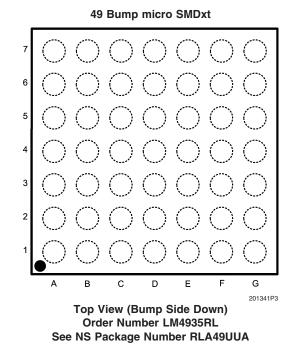
1.0 General Description	1
2.0 Applications	1
3.0 Key Specifications	
4.0 Features	
5.0 LM4935 Overview	
6.0 Typical Application	
7.0 Connection Diagrams	
7.1 PIN TYPE DEFINITIONS	
8.0 Absolute Maximum Ratings	
9.0 Operating Ratings	
10.0 Electrical Characteristics	
11.0 System Control	
11.1 I ² C SIGNALS	
11.2 I ² C DATA VALIDITY	17
11.3 I ² C START AND STOP CONDITIONS	
11.4 TRANSFERRING DATA	
11.5 I ² C TIMING PARAMETERS	19
12.0 Status & Control Registers	21
12.1 BASIC CONFIGURATION REGISTER	
12.2 CLOCKS CONFIGURATION REGISTER	
12.3 LM4935 CLOCK NETWORK	
12.4 COMMON CLOCK SETTINGS FOR THE DAC & ADC	25
12.5 PLL M DIVIDER CONFIGURATION REGISTER	26
12.6 PLL N DIVIDER CONFIGURATION REGISTER	
12.7 PLL P DIVIDER CONFIGURATION REGISTER	28
12.8 PLL N MODULUS CONFIGURATION REGISTER	29
12.9 FURTHER NOTES ON PLL PROGRAMMING	
12.10 ADC_1 CONFIGURATION REGISTER	
12.11 ADC_2 CONFIGURATION REGISTER	
12.12 AGC_1 CONFIGURATION REGISTER	
12.13 AGC_2 CONFIGURATION REGISTER	35
12.14 AGC_3 CONFIGURATION REGISTER	
12.15 AGC OVERVIEW	
12.16 MIC_1 CONFIGURATION REGISTER	
12.17 MIC_2 CONFIGURATION REGISTER	
12.18 SIDETONE ATTENUATION REGISTER	
12.19 CP_INPUT CONFIGURATION REGISTER	41
12.20 AUX_LEFT CONFIGURATION REGISTER	
12.21 AUX_RIGHT CONFIGURATION REGISTER	43
12.22 DAC CONFIGURATION REGISTER	
12.23 CP_OUTPUT CONFIGURATION REGISTER	
12.24 AUX_OUTPUT CONFIGURATION REGISTER	
12.25 LS_OUTPUT CONFIGURATION REGISTER	47
12.26 HP_OUTPUT CONFIGURATION REGISTER	
12.27 EP_OUTPUT CONFIGURATION REGISTER	
12.28 DETECT CONFIGURATION REGISTER	
12.29 HEADSET DETECT OVERVIEW	
12.30 STATUS REGISTER	
12.31 AUDIO INTERFACE CONFIGURATION REGISTER	
12.32 DIGITAL AUDIO DATA FORMATS	56
12.33 GPIO CONFIGURATION REGISTER	
12.34 SAR CHANNELS 0 & 1 CONFIGURATION REGISTER	
12.35 SAR CHANNELS 2 & 3 CONFIGURATION REGISTER	
12.36 SAR DATA 0 TO 3 REGISTERS	
12.37 SAR OVERVIEW	
12.38 DC VOLUME CONFIGURATION REGISTER	
12.39 SAR TRIGGER 1 CONFIGURATION REGISTER	
12.40 SAR TRIGGER 1 MSBs CONFIGURATION REGISTER	
12.41 SAR TRIGGER 2 CONFIGURATION REGISTER	
12.42 SAR TRIGGER 2 MSBs CONFIGURATION REGISTER	
12.43 DEBUG REGISTER	
13.0 Typical Performance Characteristics	69

LM4935

Table of Contents (Continued)

14.0 LM4935 Demonstration Board Schematic Diagram	105
15.0 Demoboard PCB Layout	106
16.0 Product Status Definitions	111
17.0 Revision History	112
18.0 Physical Dimensions	113

7.0 Connection Diagrams



49 Bump micro SMDxt Marking XYTT GG7 Pin A1 20134107 Top View XY — Date Code TT — Die Traceability G — Boomer G7 — LM4935RL

7.0 Connection Diagrams (Continued)

Pin Descriptions

Pin	Pin Name	Туре	Direction	Description
A1	EP_NEG	Analog	Output	Earpiece negative output
A2	A_V _{DD}	Supply	Input	Headphone and mixer V _{DD}
A3	INT_MIC_POS	Analog	Input	Internal microphone positive input
A4	EXT_MIC	Analog	Input	External microphone input
A5	VSAR2	Analog	Input	Input to SAR channel 2
A6	VSAR1	Analog	Input	Input to SAR channel 1
A7	PLL_V _{SS}	Supply	Input	PLL V _{SS}
B1	A_V _{SS}	Supply	Input	Headphone and mixer V _{SS}
B2	EP_POS	Analog	Output	Earpiece positive output
B3	INT_MIC_NEG	Analog	Input	Internal microphone negative input
B4	BYPASS	Analog	Inout	A_V _{DD} /2 filter point
B5	TEST_MODE/CS	Digital	Input	If SPI_MODE = 1, then this pin becomes \overline{CS} . If SPI_MODE = 0, and TEST_MODE/ \overline{CS} = 1, then this places the LM4935 into test mode.
B6	PLL_FILT	Analog	Inout	Filter point for PLL VCO input
B7	PLL_V _{DD}	Supply	Input	PLL V_{DD}
C1	HP_R	Analog	Output	Headphone Right Output
C2	EXT_BIAS	Analog	Output	External microphone supply (2.0/2.5/2.8/3.3V)
C3	INT_BIAS	Analog	Output	2.0V/2.5V ultra-clean supply for internal microphone
C4	AUX_R	Analog	Input	Right Analog Input
C5	GPIO_2	Digital	Inout	General Purpose I/O 2
C6	SDA	Digital	Inout	Control Data, I2C_SDA or SPI_SDI
C7	SCL	Digital	Input	Control Clock, I2C_SCL or SPI_SCK
D1	HP_L	Analog	Output	Headphone Left Output
D2	VREF_FLT	Analog	Inout	Filter point for the microphone power supply
D3	AUX_L	Analog	Input	Left Analog Input
D4	SPI_MODE	Digital	Input	Control mode select 1 = SPI, 0 = I2C (or test)
 D5	GPIO_1	Digital	Inout	General Purpose I/O 1
D6	BB_V _{DD}	Supply	Input	Baseband V_{DD} for the digital I/Os
D7	D_V _{DD}	Supply	Input	Digital V_{DD}
E1	HP_VMID	Analog	Inout	Virtual Ground for Headphones in OCL mode, otherwise 1st headset detection input
E2	HP_VMID_FB	Analog	Inout	VMID Feedback in OCL mode, otherwise a 2nd headset detection input
E3	MIC_DET	Analog	Input	Headset insertion/removal and Microphone presence detection input
 E4	CPI_NEG	Analog	Input	Cell Phone analog input negative
E5	IRQ	Digital	Output	Interrupt request signal (NOT open drain)
E6	I2S_SDO	Digital	Output	I2S Serial Data Out
 E7	12S_SDI	Digital	Input	I2S Serial Data Input
 F1	LS_V _{DD}	Supply	Input	Loudspeaker V _{DD}
F2	LS_V _{DD}	Supply	Input	Loudspeaker V _{DD}
F3	CPI_POS	Analog	Input	Cell Phone analog input positive
	CPO_NEG	Analog	Output	Cell Phone analog output negative
F5	AUX_OUT_NEG	Analog	Output	Auxiliary analog output negative
 F6	12S_WS	Digital	Inout	I2S Word Select Signal (can be master or slave)
F7	I2S_CLK	Digital	Inout	I2S Clock Signal (can be master or slave)
G1	LS_POS	Analog	Output	Loudspeaker positive output
G2	LS_V _{ss}	Supply	Input	Loudspeaker V _{SS}
G3	LS_NEG	Analog	Output	Loudspeaker negative output
G4	CPO_POS	Analog	Output	Cell Phone analog output positive
G5	AUX_OUT_POS	Analog	Output	Auxiliary analog output positive
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7.0 Connection Diagrams (Continued)

Pin Descriptions (Continued)

Pin	Pin Name	Туре	Direction	Description
G6	D_V_{SS}	Supply	Input	Digital V _{SS}
G7	MCLK	Digital	Input	Input clock from 0.5 MHz to 30 MHz

7.1 PIN TYPE DEFINITIONS never driven. Digital Output-A pin that is driven by the device and Analog Input— A pin that is used by the analog and is never driven by the device. Supplies are should not be driven by another device to part of this classification. avoid contention. Analog Output— A pin that is driven by the device and Digital Inout— A pin that is either open drain (I2C_SDA) or a bidirectional CMOS in/out. In the should not be driven by external sources. later case the direction is selected by a Analog Inout— A pin that is typically used for filtering a control register within the LM4935. DC signal within the device, Passive components can be connected to these pins.

Digital Input— A pin that is used by the digital but is

8.0 Absolute Maximum Ratings

(Notes 1, 2)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/ Distributors for availability and specifications.

Analog Supply Voltage (A_V _{DD} & LS_V _{DD}) Digital Supply Voltage	6.0V
$(BB_V_{DD} \& D_V_{DD} \& PLL_V_{DD})$	6.0V
Storage Temperature	–65°C to +150°C
Power Dissipation (Note 3)	Internally Limited
ESD Susceptibility	
Human Body Model (Note 4)	2500V
Machine Model (Note 5)	200V

Junction Temperature $150^{\circ}C$ Thermal Resistance $\theta_{JA} - RLA49$ (soldered downto PCB with 2in² 1oz. copperplane) $60^{\circ}C/W$ Soldering Information

9.0 Operating Ratings

-40°C to +85°C
2.7V to 4.5V
1.8V to 4.5V
2.7V to 5.5V

10.0 Electrical Characteristics (Notes 1, 2) Unless otherwise stated $PLL_V_{DD} = 3.3V$, $D_V_{DD} = 3.3V$, $BB_V_{DD} = 1.8V$, $A_V_{DD} = 3.3V$, $LS_V_{DD} = 3.3V$. The following specifications apply for the circuit shown in *Figure 2* unless otherwise stated. Limits apply for 25°C.

			LM49		
Symbol	Parameter	Conditions	Typical (Note 6)	Limit (Note 7)	Units
DC CURREN	T CONSUMPTION		, ,	, ,	
		Chip Mode '00', f _{MCLK} = 13MHz	0.7		μA
DI _{SD}	Digital Shutdown Current	Chip Mode '00', f _{MCLK} = 19.2MHz	0.7	5	μA (max)
		Chip Mode '01', f _{MCLK} = 13MHz	1.5		mA
DI _{ST}	Digital Standby Current	Chip Mode '01', f _{MCLK} = 19.2MHz	2.2	3	mA (max)
		Chip Mode '10', f _{MCLK} = 13MHz, DAC, ADC, SAR OFF	1.5		mA
DI .	Digital Active Current	Chip Mode '10', f _{MCLK} = 19.2MHz, DAC, ADC, SAR OFF	2.2		mA
DI _{DD}		Chip Mode '10', f _{MCLK} = 13MHz DAC, ADC, SAR ON	11.2		mA
		Chip Mode '10', f _{MCLK} = 19.2MHz, DAC, ADC, SAR ON	16.2	20	mA (max)
Al _{SD}	Analog Shutdown Current	Chip Mode '00'	0.2	3	μA (max)
Al _{st}	Analog Standby Current	Chip Mode '01', No headset inserted	0.2	3	μA (max)
		All Outputs OFF, SE MODE	6.1		mA
		All Outputs OFF, OCL MODE	5.7		mA
Al _{DD}	Analog Active Current	All Outputs ON, SE MODE	18.3		mA
		All Outputs ON, OCL MODE	18.7	28	mA (max)
	PLL Active Current	f _{MCLK} = 13 MHz f _{PLLOUT} = 12 MHz, PLL ON only	4.2		mA
PLLI _{DD}		f _{MCLK} = 19.2 MHz f _{PLLOUT} = 12 MHz, PLL ON only	6.2		mA
ADCI _{DD}	ADC Active Current	f _{MCLK} = 13MHz, ADC ON only	2.5		mA
		f _{MCLK} = 19.2MHz, ADC ON only	3.6		mA

LM4935

LM4935

10.0 Electrical Characteristics (Notes 1, 2) Unless otherwise stated PLL_V_{DD} = 3.3V, D_V_{DD} = 3.3V, BB_V_{DD} = 1.8V, A_V_{DD} = 3.3V, LS_V_{DD} = 3.3V. The following specifications apply for the circuit shown in *Figure 2* unless otherwise stated. Limits apply for 25°C. (Continued)

			LM49)35	
Symbol	Parameter	Conditions	Typical (Note 6)	Limit (Note 7)	Units
DC CURREN	IT CONSUMPTION				
		f _{MCLK} = 13MHz, DAC ON only;	7.4		mA
DACIDD	DAC Active Current	PLL OFF, f _S = 48kHz	7.4		
DAOIDD		f_{MCLK} = 19.2MHz, DAC ON only	10.7		mA
		PLL OFF; f _S = 48kHz	10.7		
SARIDD	SAR Active Current	f _{MCLK} = 13MHz, SAR ON only	1.6		mA
0,		f _{MCLK} = 19.2MHz, SAR ON only	2.3		mA
LSI _{DD}	Loudspeaker Quiescent Current	LS ON only	8.8		mA
HPIDD	Headphone Quiescent Current	HP ON only, SE MODE	3.5		mA
		HP ON only, OCL MODE	3.9		mA
EPI _{DD}	Earpiece Quiescent Current	EP ON only	4.4		mA
AUXI _{DD}	AUXOUT Quiescent Current	AUXOUT ON only	4.8		mA
CPOUTI _{DD}	CPOUT Quiescent Current	CPOUT ON only	4.8		mA
LOUDSPEAK	KER AMPLIFIER				
P _{LS}	Max Loudspeaker Power	8Ω load, LS_V _{DD} = 5V	1.3		W
		8Ω load, LS_V _{DD} = 4.2V	0.9		W
		8Ω load, LS_V _{DD} = 3.3V	0.6	0.44	W (min
LS _{THD+N}	Loudspeaker Harmonic Distortion	8Ω load, LS_V _{DD} = 3.3V,	0.4		0/
		$P_{O} = 400 \text{mW}$	0.4		%
LS _{EFF}	Efficiency	0 dB Input	84		%
		MCLK = 12.000 MHz	04		/0
PSRR _{LS}	Power Supply Rejection Ration	AUX inputs terminated			
	(Loudspeaker)	$C_{BYPASS} = 1.0 \ \mu F$	54		dB
		$V_{\text{RIPPLE}} = 200 \text{ mV}_{\text{P-P}}$	01		üD
		f _{RIPPLE} = 217 Hz			
SNR_{LS}	Signal to Noise Ratio	From 0 dB Analog AUX input at	76		dB
		1 kHz, A-weighted	-		-
e _N	Output Noise	A-weighted	350		μV
V _{os}	Offset Voltage		7		mV
	EAMPLIFIER	1	1		
P _{HP}	Headphone Power	32Ω load, 3.3V, SE	33	20	mW
					(min)
		16Ω load, 3.3V, SE	52		mW
		32Ω load, 3.3V, OCL, VCM = 1.5V	31		mW
		32Ω load, 3.3V, OCL, VCM = 1.2V	20		mW
		16Ω load, 3.3V, OCL, VCM = 1.5V	50		mW
		16Ω load, 3.3V, OCL, VCM = 1.2V	32		mW
		AUX inputs terminated			
		$C_{BYPASS} = 1.0 \ \mu F$			
		$V_{\text{RIPPLE}} = 200 \text{ mV}_{\text{P-P}}$			
	Power Supply Rejection Ratio	f _{RIPPLE} = 217 Hz			
PSRR _{HP}	(Headphones)	SE Mode	60		dB
		OCL Mode	68		dB
		VCM = 1.2V			
		OCL Mode	65		dB
		VCM = 1.5V		1	

10.0 Electrical Characteristics (Notes 1, 2) Unless otherwise stated $PLL_V_{DD} = 3.3V$, $D_V_{DD} = 3.3V$, $BB_V_{DD} = 1.8V$, $A_V_{DD} = 3.3V$, $LS_V_{DD} = 3.3V$. The following specifications apply for the circuit shown in *Figure 2* unless otherwise stated. Limits apply for 25°C. (Continued)

			LM49		
Symbol	Parameter	Conditions	Typical (Note 6)	Limit (Note 7)	Units
HEADPHON		•			
		From 0dB Analog AUX input			
		A-weighted			
		SE Mode	98		dB
SNR _{HP}	Signal to Noise Ratio	OCL Mode	97		dB
		VCM = 1.2V			40
		OCL Mode	96		dB
		VCM = 1.5V	_		
HP_{THD+N}	Headphone Harmonic Distortion	32Ω load, $3.3V$, $P_0 = 7.5mW$	0.05		%
e _N	Output Noise	A-weighted	12		μV
ΔA_{CH-CH}	Stereo Channel-to-Channel Gain Mismatch		0.3		dB
v	Starge Creestell	SE Mode	61		dB
X _{talk}	Stereo Crosstalk	OCL Mode	63		dB
EARPIECE	AMPLIFIER			ı	
P _{EP}	Earpiece Power	32Ω load, 3.3V	115	100	mW (min)
		16Ω load, 3.3V	150		mW
PSRR _{EP}	Power Supply Rejection Ratio	AUX inputs terminated			
	(Earpiece)	C _{BYPASS} = 1.0 µF	05		٩D
		$V_{\text{RIPPLE}} = 200 \text{ mV}_{\text{P-P}}$	65		dB
		F _{RIPPLE} = 217 Hz			
SNR _{EP}	Signal to Noise Ratio	From 0dB Analog AUX input,	98		dB
		A-weighted			UD
EP_{THD+N}	Earpiece Harmonic Distortion	32Ω load, $3.3V$, $P_O = 50mW$	0.04		%
e _N	Output Noise	A-weighted	24		μV
V _{os}	Offset Voltage		15		mV
AUXOUT AN	MPLIFIER				
THD+N	Total Harmonic Distortion + Noise	$V_{O} = 1V_{RMS}$, 5k Ω load	0.02		%
PSRR	Power Supply Rejection Ratio	AUX inputs terminated			
		$C_{BYPASS} = 1.0 \mu F$	70		dB
		V _{RIPPLE} = 200mVPP			0.2
		f _{RIPPLE} = 217Hz			
CP_OUT AN			1		
THD+N	Total Harmonic Distortion + Noise	$V_{O} = 1V_{RMS}$, 5k Ω load	0.02		%
PSRR	Power SUpply Rejection Ratio	$C_{BYPASS} = 1.0 \mu F$			
		$V_{\text{RIPPLE}} = 200 \text{mVPP}$	68		dB
		f _{RIPPLE} = 217Hz			
MONO ADC		1	10.05	1 1	
R _{ADC}	ADC Ripple		±0.25		dB
PB _{ADC}	ADC Passband	Lower (HPF Mode 1), f _S = 8 kHz	300		Hz
		Upper	3470		Hz
SBA _{ADC}	ADC Stopband Attenuation	Above Passband	60		dB
		HPF Notch, 50 Hz/60 Hz (worst case)	58		dB
SNR _{ADC}	ADC Signal to Noise Ratio	From CPI, A-weighted	90		dB
ADCLEVEL	ADC Full Scale Input Level		1		V _{RMS}

LM4935

LM4935

10.0 Electrical Characteristics (Notes 1, 2) Unless otherwise stated PLL_V_{DD} = 3.3V, D_V_{DD} = 3.3V, BB_V_{DD} = 1.8V, A_V_{DD} = 3.3V, LS_V_{DD} = 3.3V. The following specifications apply for the circuit shown in *Figure 2* unless otherwise stated. Limits apply for 25°C. (Continued)

	Parameter	Conditions	LM49	1	
Symbol			Typical (Note 6)	Limit (Note 7)	Units
STEREO DAC					
R _{DAC}	DAC Ripple		0.1		dB
PB _{DAC}	DAC Passband		20		kHz
SBA _{DAC}	DAC Stopband Attenuation		70		dB
SNR _{DAC}	DAC Signal to Noise Ratio	A-weighted, AUXOUT	88		dB
DR _{DAC}	DAC Dynamic Range		96		dB
DAC _{LEVEL}	DAC Full Scale Output Level		1		V _{RMS}
PLL				1	1
F _{IN}	Input Frequency Range	Min	0.5		MHz
		Max	30		MHz
I2S/PCM		I		1	
		f _s = 48kHz; 16 bit mode	1.536		MHz
t		$f_s = 48$ kHz; 25 bit mode	2.4		MHz
f _{I2SCLK}	I2S CLK Frequency	f _s = 8kHz; 16 bit mode	0.256		MHz
		f _s = 8kHz; 25 bit mode	0.4		MHz
		f _S = 48kHz; 16 bit mode	0.768		MHz
_		f _s = 48kHz; 25 bit mode	1.2		MHz
f _{PCMCLK}	PCM CLK Frequency	f _s = 8kHz; 16 bit mode	0.128		MHz
		f _S = 8kHz; 25 bit mode	0.2		MHz
DC _{I2S_CLK}	I2S_CLK Duty Cycle	Min		40	% (mi
123_0LK		Max		60	%
	I2S_WS Duty Cycle		50	00	(max %
DC _{I2S_WS}			50		/0
	I2C Data Setup Time	Pofor to Pa 19 for more dotaile		100	no (mi
T _{I2CSET}	I2C Data Setup Time	Refer to Pg. 18 for more details Refer to Pg. 18 for more details		100 300	ns (m
T _{I2CHOLD}		nelei lo Fy. To foi more details		300	ns (mi
_	Enable Setup Time			100	ns (m
T _{SPISETENB}					
T _{SPIHOLD-ENB}	Enable Hold Time			100	ns (m
	Data Setup Time			100	ns (m
T _{SPIHOLDD}	Data Hold Time			100	ns (m
T _{SPICL}	Clock Low Time			500	ns (m
	Clock High Time			500	ns (m
VOLUME CON			40 5	1	-10-
		Minimum Gain w/ AUX_BOOST OFF	-46.5		dB
VCR _{AUX}	AUX Volume Control Range	Maximum Gain w/ AUX_BOOST OFF	0		dB
AUA		Minimum Gain w/ AUX_BOOST ON	-34.5		dB
		Maximum Gain w/ AUX_BOOST ON	12		dB
		Minimum Gain w/ DAC_BOOST OFF	-46.5		dB
		Maximum Gain w/ DAC_BOOST	0		dB
VCR _{DAC}	DAC Volume Control Range	OFF Minimum Gain w/ DAC_BOOST ON	-34.5		심다
					dB
		Maximum Gain w/ DAC_BOOST ON	12		dB
VCR _{CPIN}	CPIN Volume Control Range	Minimum Gain	-34.5		dB
5		Maximum Gain	12		dB

10.0 Electrical Characteristics (Notes 1, 2) Unless otherwise stated $PLL_V_{DD} = 3.3V$, $D_V_{DD} = 3.3V$, $BB_V_{DD} = 1.8V$, $A_V_{DD} = 3.3V$, $LS_V_{DD} = 3.3V$. The following specifications apply for the circuit shown in *Figure 2* unless otherwise stated. Limits apply for 25°C. (Continued)

			LM49		
Symbol	Parameter	Conditions	Typical	Limit	Units
			(Note 6)	(Note 7)	
VOLUME CO	ONTROL	^ 	•		
	VCR _{MIC} MIC Volume Control Range	Minimum Gain	6		dB
VCR _{MIC}		Maximum Gain	36		dB
VCR _{SIDE}	SIDETONE Volume Control Range	Minimum Gain	-30		dB
		Maximum Gain	0		dB
SS _{AUX}	AUX VCR Stepsize		1.5		dB
SS _{DAC}	DAC VCR Stepsize		1.5		dB
SS _{CPIN}	CPIN VCR Stepsize		1.5		dB
SS _{MIC}	MIC VCR Stepsize		2		dB
SS _{SIDE}	SIDETONE VCR Stepsize		3		dB

LM4935

LM4935

10.0 Electrical Characteristics (Notes 1, 2) Unless otherwise stated PLL_V_{DD} = 3.3V, D_V_{DD} = 3.3V, BB_V_{DD} = 1.8V, A_V_{DD} = 3.3V, LS_V_{DD} = 3.3V. The following specifications apply for the circuit shown in *Figure 2* unless otherwise stated. Limits apply for 25°C. (Continued)

			LM4935		
Symbol	Parameter	Conditions	Typical (Note 6)	Limit (Note 7)	Units
UDIO PATH	GAIN W/ STEREO (bit 6 of 0x00h) E	NABLED (AUX_L & AUX_R signals ide		lected onto	mixer)
		Minimum Gain from AUX input, BOOST OFF	-34.5		dB
	Loudspeaker Audio Path Gain	Maximum Gain from AUX input, BOOST OFF	12		dB
		Minimum Gain from CPI input	-22.5		dB
		Maximum Gain from CPI input	24		dB
		Minimum Gain from AUX input, BOOST OFF	-52.5		dB
		Maximum Gain from AUX input, BOOST OFF	-6		dB
		Minimum Gain from CPI input	-40.5		dB
	Headphone Audio Path Gain	Maximum Gain from CPI input	6		dB
		Minimum Gain from MIC input using SIDETONE path w/ VCR _{MIC} gain = 6dB	-30		dB
	Maximum Gain from MIC input using SIDETONE path w/ VCR _{MIC} gain = 6dB	0		dB	
		Minimum Gain from AUX input, BOOST OFF	-40.5		dB
		Maximum Gain from AUX input, BOOST OFF	6		dB
		Minimum Gain from CPI input	-28.5		dB
	Earpiece Audio Path Gain	Maximum Gain from CPI input	18		dB
		Minimum Gain from MIC input using SIDETONE path w/ VCR _{MIC} gain = 6dB	-18		dB
		Maximum Gain from MIC input using SIDETONE path w/ VCR _{MIC} gain = 6dB	12		dB
		Minimum Gain from AUX input, BOOST OFF	-46.5		dB
	AUXOUT Audio Path Gain	Maximum Gain from AUX input, BOOST OFF	0		dB
		Minimum Gain from CPI input	-34.5		dB
		Maximum Gain from CPI input	12		dB
		Minimum Gain from AUX input, BOOST OFF	-46.5		dB
	CPOUT Audio Path Gain	Maximum Gain from AUX input, BOOST OFF	0		dB
		Minimum Gain from MIC input	6		dB
		Maximum Gain from MIC input	36		dB

10.0 Electrical Characteristics (Notes 1, 2) Unless otherwise stated $PLL_V_{DD} = 3.3V$, $D_V_{DD} = 3.3V$, $BB_V_{DD} = 1.8V$, $A_V_{DD} = 3.3V$, $LS_V_{DD} = 3.3V$. The following specifications apply for the circuit shown in *Figure 2* unless otherwise stated. Limits apply for 25°C. (Continued)

			LM4935			
Symbol	Parameter Conditions		Typical (Note 6)	Limit (Note 7)	Units	
Total DC Po	wer Dissipation					
		DAC ($f_s = 48$ kHz) and HP ON				
		f _{MCLK} = 12MHz, PLL OFF	57		mW	
	MP3 Mode Power Dissipation	f _{MCLK} = 13MHz, PLL ON f _{PLLOUT} = 12MHz	63		mW	
		f_{MCLK} = 19.2MHz, PLL ON f_{PLLOUT} = 12MHz	64		mW	
		AUX Inputs selected and HP ON				
	EM Made Dewer Dissinction	f _{MCLK} = 12MHz, PLL OFF	24		mW	
	FM Mode Power Dissipation	f _{MCLK} = 13MHz, PLL OFF	25		mW	
		f _{MCLK} = 19.2MHz, PLL OFF	27		mW	
		PCM DAC (f_S = 8kHz) + ADC (f_S = 8kHz) and EP ON				
	VOICE CODEC Mode Power	f _{MCLK} = 12MHz, PLL OFF	49		mW	
	Dissipation	f _{MCLK} = 13MHz, PLL OFF	50		mW	
		f_{MCLK} = 19.2MHz, PLL ON f_{PLLOUT} = 12MHz	56		mW	
		CP IN selected. EP and CPOUT ON				
	VOICE Module Mode Power	f _{MCLK} = 12MHz, PLL OFF	30		mW	
	Dissipation	f _{MCLK} = 13MHz, PLL OFF	31		mW	
		f _{MCLK} = 19.2MHz, PLL OFF	33		mW	

LM4935

10.0 Electrical Characteristics (Notes 1, 2) Unless otherwise stated $PLL_V_{DD} = 3.3V$, $D_V_{DD} = 3.3V$, $BB_V_{DD} = 1.8V$, $A_V_{DD} = 3.3V$, $LS_V_{DD} = 3.3V$. The following specifications apply for the circuit shown in *Figure 2* unless otherwise stated. Limits apply for 25°C. (Continued)

Note 1: Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is functional but do not guarantee specific performance limits.

Characteristics state DC and AC electrical specifications under particular test conditions which guarantee specific performance limits. This assumes that the device is within the Operating Ratings. Specifications are not guaranteed for parameters where no limit is given, however, the typical value is a good indication of device performance.

Note 2: All voltages are measured with respect to the relevant V_{SS} pin unless otherwise specified. All grounds should be coupled as close as possible to the device. **Note 3:** The maximum power dissipation must be de-rated at elevated temperatures and is dictated by TJ_{MAX} , θ_{JA} , and the ambient temperature, T_A . The maximum

allowable power dissipation is $P_{DMAX} = (T_{JMAX} - T_A)/\theta_{JA}$ or the number given in Absolute Maximum Ratings, whichever is lower.

Note 4: Human body model: 100pF discharged through a $1.5 k\Omega$ resistor.

Note 5: Machine model: 220pF - 240pF discharged through all pins.

Note 6: Typical values are measured at $25^{\circ}C$ and represent the parametric norm.

Note 7: Limits are guaranteed to Nationals AOQL (Average Outgoing Quality Level).

Note 8: Best operation is achieved by maintaining $3.0V < A_V_{DD} < 5.0$ and $3.0V < D_V_{DD} < 3.6V$ and $A_V_{DD} > D_V_{DD}$.

Note 9: Digital shutdown current is measured with system clock set for PLL output while the PLL is disabled.

Note 10: Disabling or bypassing the PLL will usually result in an improvement in noise measurements.

11.0 System Control

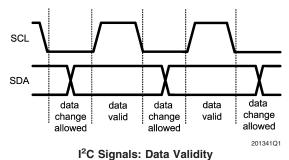
Method 1. I²C Compatible Interface

11.1 I²C SIGNALS

In I²C mode the LM4935 pin SCL is used for the I²C clock SCL and the pin SDA is used for the I²C data signal SDA. Both these signals need a pull-up resistor according to I²C specification. The I²C slave address for LM4935 is **0011010₂**.

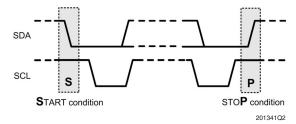
11.2 I²C DATA VALIDITY

The data on SDA line must be stable during the HIGH period of the clock signal (SCL). In other words, state of the data line can only be changed when SCL is LOW.



11.3 I²C START AND STOP CONDITIONS

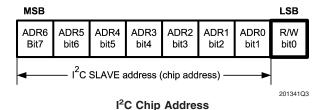
START and STOP bits classify the beginning and the end of the I^2C session. START condition is defined as SDA signal transitioning from HIGH to LOW while SCL line is HIGH. STOP condition is defined as the SDA transitioning from LOW to HIGH while SCL is HIGH. The I^2C master always generates START and STOP bits. The I^2C bus is considered to be busy after START condition and free after STOP condition. During data transmission, I^2C master can generate repeated START conditions. First START and repeated START conditions are equivalent, function-wise.



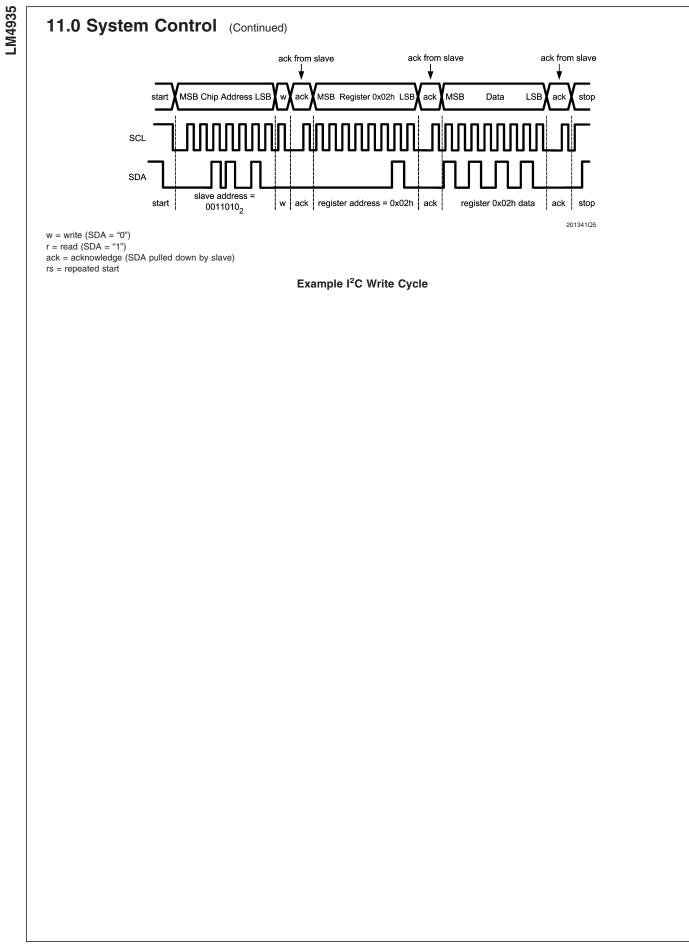
11.4 TRANSFERRING DATA

Every byte put on the SDA line must be eight bits long, with the most significant bit (MSB) being transferred first. Each byte of data has to be followed by an acknowledge bit. The acknowledge related clock pulse is generated by the master. The transmitter releases the SDA line (HIGH) during the acknowledge clock pulse. The receiver must pull down the SDA line during the 9th clock pulse, signifying an acknowledge. A receiver which has been addressed must generate an acknowledge after each byte has been received.

After the START condition, the I^2C master sends a chip address. This address is seven bits long followed by an eighth bit which is a data direction bit (R/W). The LM4935 address is **0011010**₂. For the eighth bit, a "0" indicates a WRITE and a "1" indicates a READ. The second byte selects the register to which the data will be written. The third byte contains data to write to the selected register.

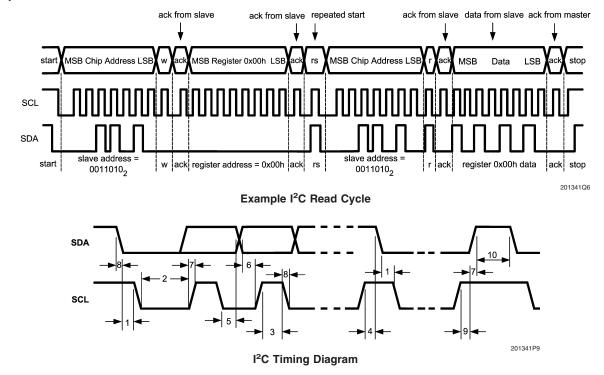


Register changes take an effect at the SCL rising edge during the last ACK from slave.



11.0 System Control (Continued)

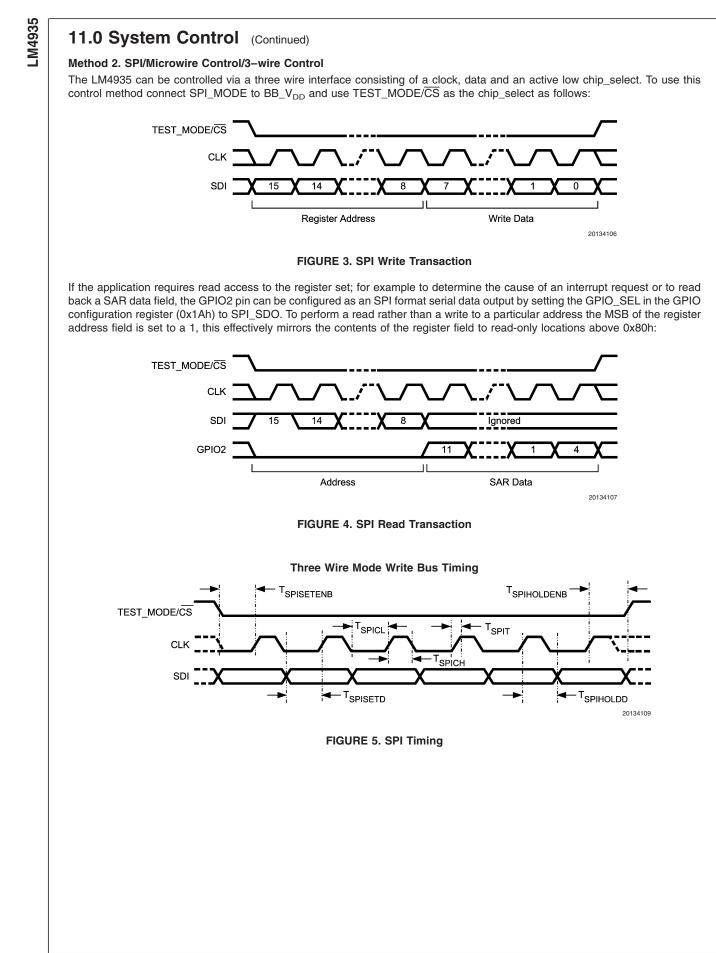
When a READ function is to be accomplished, a WRITE function must precede the READ function, as shown in the Read Cycle waveform.



11.5 I²C TIMING PARAMETERS

Symbol	Parameter	Limit	Units	
		Min	Мах	
1	Hold Time (repeated) START Condition	0.6		μs
2	Clock Low Time	1.3		μs
3	Clock High Time	600		ns
4	Setup Time for a Repeated START Condition	600		ns
5	Data Hold Time (Output direction, delay generated by LM4935)	300	900	ns
5	Data Hold Time (Input direction, delay generated by the Master)	0	900	ns
6	Data Setup Time	100		ns
7	Rise Time of SDA and SCL	20+0.1C _b	300	ns
8	Fall Time of SDA and SCL	15+0.1C _b	300	ns
9	Set-up Time for STOP condition	600		ns
10	Bus Free Time between a STOP and a START Condition	1.3		μs
C _b	Capacitive Load for Each Bus Line	10	200	pF

NOTE: Data guaranteed by design



Address 0x00h 0x01h 0x02h 0x03h 0x04h 0x05h 0x06h	Register BASIC CLOCKS PLL_M	7 OCL	6	5					
0x01h 0x02h 0x03h 0x04h 0x05h	CLOCKS	OCL		•	4	3	2	1	0
0x02h 0x03h 0x04h 0x05h			STEREO	CAP_	SIZE	USE_OSC	PLL_ENB	CHP_	MODE
0x03h 0x04h 0x05h	PLL M			R_D	VIV			ADCLK	DACCLK
0x04h 0x05h		PLLINPUT			PLL_M				RSVD
0x05h	PLL_N				PLL_I	N			
	PLL_P	RSVD		Q_DIV			PLL_P		RSVD
0x06h	PLL_MOD	RSVD	DITHEF	LEVEL		F	PLL_N_MOD		
	ADC_1	HPF_N	IODE	SAMPLI	E_RATE	RIGHT	LEFT	CPI	MIC
0x07h	ADC_2	IF216	ADC_I2SM	AGO	C_FRAME_TI	ME	ADCMUTE	COMPND	U/ALAW
0x08h	AGC_1	NOISE_	GATE_THRE	SHOLD	NG_ON	A	GC_TARGE	Г	AGC_ENB
0x09h	AGC_2	AGC_TIGHT		AGC_DECAY	,		AGC_MA	X_GAIN	
0x0Ah	AGC_3	A	GC_ATTACK			AGO	C_HOLD_TIM	1E	
0x0Bh	MIC_1		INT_EXT	SE_DIFF	MUTE		PREAM	P_GAIN	
0x0Ch	MIC_2			BTN_DEBO	UNCE_TIME	BTNTYPE	MIC_BIAS_	VOLTAGE	VCMVOLT
0x0Dh	SIDETONE						SIDETONI	E_ATTEN	
0x0Eh	CP_INPUT			MUTE		(CPI_LEVEL		
0x0Fh	AUX_LEFT	AUX_DAC	MUTE	BOOST		AUX	LEFT_LEV	EL	
0x10h	AUX_RIGHT	AUX_DAC	MUTE	BOOST		AUX	_RIGHT_LEV	/EL	
0x11h	DAC	DACMUTE	BOOST	USAXLVL		C	DAC_LEVEL		
0x12h	CP_OUTPUT				MICGATE	MUTE	LEFT	RIGHT	MIC
0x13h	AUX OUTPUT					MUTE	LEFT	RIGHT	CPI
0x14h	LS_OUTPUT					MUTE	LEFT	RIGHT	CPI
0x15h	HP_OUTPUT				MUTE	LEFT	RIGHT	CPI	SIDE
0x16h	EP_OUTPUT				MUTE	LEFT	RIGHT	CPI	SIDE
0x17h	DETECT			HS_DBN	IC_TIME		TEMP_INT	BTN_INT	DET_INT
0x18h	STATUS	GPIN	TEMP	SARTRG2	SARTRG1	BTN	MIC	STEREO	HEADSET
0x19h	AUDIO_IF	I2S_SDC	_DATA	PCMCLMS	PCMSYMS	I2SCLKMS	I2SWSMS	AUDIO_	IF_MODE
0x1Ah	GPIO	GPIODATA	PCM_LNG	I2S_MODE	SAR_C	H_SEL		GPIO_SEL	
0x1Bh	SAR_SLT0/1	SLT1ENB		SLOT1_FS		SLT0ENB		SLOT0_FS	
0x1Ch	SAR_SLT2/3			SLT2VBB	SLT3ENB	SLT2ENB		SLOT2_FS	
0x1Dh	SAR_DATA_0				SLOT0_D	DATA			
0x1Eh	SAR_DATA_1				SLOT1_D	DATA			
0x1Fh	SAR_DATA_2				SLOT2_D	DATA			
0x20h	SAR_DATA_3				SLOT3_D	DATA			
0x21h	DC_VOL					MAX	_LVL	EFFECT	DCVLENB
0x22h	TRIG_1		TRIG_	1 [3:0]		SOU	IRCE	DIR	ENB
0x23h	TRIG_1_MSB				TRIG_1 [11:4]			
0x24h	TRIG_2		TRIG_	2 [3:0]		SOU	IRCE	DIR	ENB
0x25h	TRIG_2_MSB				TRIG_2 [11:4]			
0x26h	DEBUG	GPIO_TEST	RSVD	RSVD	RSVD	SOFT	RSVD	RSVD	RSVD
		_MODE				RESET			
	Fo	r all registers,	the default	setting of dat	ta bits 7 thro	ugh 0 are al	I set to zero	•	
			RESERVED	bits should a	lways be set	to zero.			

12.1 BASIC CONFIGURATION REGISTER

This register is used to control the basic function of the chip.

TABLE 2. BASIC (0x00h)

Bits	Field		Description						
1:0	CHIP_MODE	The LM4935 can	The LM4935 can be placed in one of four modes which dictate its basic operation. When a new						
		mode is selected the LM4935 will change operation silently and will re-configure the power							
		management pro	management profile automatically. The modes are described as follows:						
		CHIP MODE	Audio System	Detection System	Typical Application				
		002	Off	Off	Power-down Mode				
		012	Off	On	Stand-by mode with headset event				
			det						
		10 ₂	On	Off	Active without headset event detection				
		11 ₂	On	On	Active with headset event detection				
2	PLL_ENABLE	If set the PLL car	If set the PLL can be used.						
3	USE_OSC	If set the power management and control circuits will assume that no external clock is available and							
		will resort to using an on-chip oscillator for SAR, headset detection and analog power management							
		functions such as click and pop.							
5:4	CAP_SIZE	Programs the extra delays required to stabilize once charge/discharge is complete, based on the size							
			of the bypass capacitor.						
		CAP_SIZE	Bypass C	apacitor Size	Turn-off/on time				
		002	0	.1 μF	45 ms/75 ms				
		012		1 µF	45 ms/140 ms				
		10 ₂	2	.2 μF	45 ms/260 ms				
		11 ₂	4	.7 μF	45 ms/500 ms				
6	STEREO	If set, the mixers	assume that the s	ignals on the left and i	right internal busses are highly correlated				
			0		uced by 6 dB to allow enough headroom for				
		them to be summed at the Loudspeaker, Earpiece, CPOUT, and AUXOUT amplifiers. For the							
					nal levels are routed to the corresponding				
					t and the right signals are added and routed				
			· ·		y 6dB to allow enough headroom.				
7	OCL	If set the part is	placed in OCL (Out	tput Capacitor Less) m	node.				

For reliable headset / push button detection the following bits should be defined before enabling the headset detection system by setting bit 0 of CHIP_MODE:

The OCL-bit (Cap / Capless headphone interface; bit 7 of this register)

The headset insert/removal debounce settings (bits 6:3 of DETECT (0x17h))

The BTN_TYPE-bit (Parallel / Series push button type; bit 3 MIC_2 register (0x0Ch))

The parallel push button debounce settings (bits 5:4 of MIC_2 register (0x0Ch))

All register fields controlling the audio system should be defined before setting bit 1 of CHIP_MODE and should not be altered while the audio sub-system is active.

If the analog or digital levels are below -12 dB then it is not necessary to set the stereo bit allowing greater output levels to be obtained for such signals.

12.2 CLOCKS CONFIGURATION REGISTER

This register is used to control the clocks throughout the chip.

		TABLE 3. CLOCKS (0x01h)			
Bits	Field	Description				
0	DAC_CLK	Selects the clock to be used by the audio DAC system.				
		DAC_CLK	DAC Input Source			
		0	PLL Input (MCLK or I2S_CLK)			
		1	PLL Output			
1	ADC_CLK	Selects the clock to be used by the audio ADC sys	tem.			
		ADC_CLK	Audio ADC Input Source			
		0	MCLK			
		1	PLL Output			
7:2	R_DIV	Programs the R divider (divides from an expected 12.000 MHz input).				
		R_DIV	Divide Value			
		0	Bypass			
		1	Bypass			
		2	1.5			
		3	2			
		4	2.5			
		5	3			
		6	3.5			
		7	4			
		8	4.5			
		9	5			
		10	5.5			
		11	6			
		12	6.5			
		13 to 61	7 to 31			
		62	31.5			
		63	32			

12.3 LM4935 CLOCK NETWORK

The audio ADC operates at 125*fs, so it requires a 1.000 MHz clock to sample at 8 kHz (at point **C** as marked on the following diagram). The stereo DAC operates at 250*fs, i.e. 12.000 MHz (at point **B**) for 48 kHz data. It is expected that the PLL is used to drive the audio system unless a 12.000 MHz master clock is supplied and the sample rate is always a multiple of 8 kHz, in which case the PLL can be bypassed to reduce power, clock division instead being performed by the Q and R dividers. The PLL can also use the I2S clock input as a source. In this case, the audio DAC uses the clock from the output of the PLL and the audio ADC either uses the PLL output divided by 2*FSDAC/FSADC or a system clock divided by Q, this allows n*8 kHz recording and 44.1 kHz playback.

MCLK must be less than or equal to 30 MHz, the I2S clock should be an integer multiple of the DAC's sampling frequency and should be below 6 MHz.

When using the Class D amplifier with the DAC the Class D clock generator will assume 12 MHz at point **A**, if this is not the case then the DAC and power stage may become unsynchronized and SNR performance may be reduced.

The LM4935 is designed to work from a 12.000 MHz or 11.025 MHz clock at point **A**. This is used to drive the power management and control logic. Performance may not meet the electrical specifications if the frequency at this point deviates significantly beyond this range.

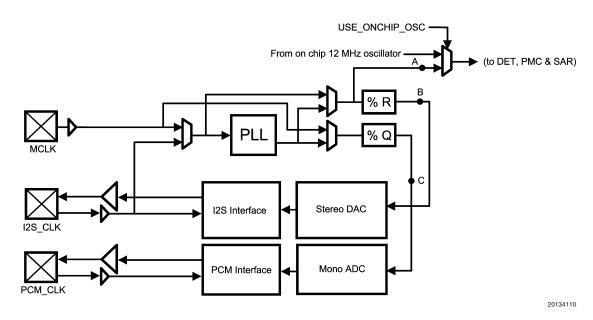


FIGURE 6. LM4935 Clock Network

12.4 COMMON CLOCK SETTINGS FOR THE DAC & ADC

The DAC has an over sampling rate of 125 but requires a 250*fs clock at point **B**. This allows a simple clocking solution as it will work from 12.000 MHz (common in most systems with Bluetooth or USB) at 48 kHz exactly, the following table describes the clock required at point **B** for various clock sample rates in the different DAC modes:

TABLE 4. Common DAC Clock Frequencies					
DAC Sample Rate (kHz)	Clock Required at B (MHz)				
8	2				
11.025	2.75625				
12	3				
16	4				
22.05	5.5125				
24	6				
32	8				
44.1	11.025				
48	12				

TABLE 4. Common DAC Clock Frequencies

The ADC has an over sampling ratio of 125 so the table below shows the required clock frequency at point C.

TABLE 5. Common ADC Clock Frequencies

ADC Sample Rate (kHz)	Clock Required at C (MHz)
8	1
11.025	1.378125
12	1.5
16	2
22.05	2.75625
24	3

Methods for producing these clock frequencies are described in the PLL Section.

12.5 PLL M DIVIDER CONFIGURATION REGISTER

This register is used to control the input section of the PLL.

TABLE 6. PLL_M (0x02h)

		TABLE 6. PLL_W (0X021)				
Bits	Field	Description				
0	RSVD	RESERVED				
6:1	PLL_M	PLL_M	Input Divider Value			
		0	1			
		1	2			
		2	3			
		3	4			
		462	563			
		63	64			
7	PLL_INPUT	Programs the PLL input multiplexer to select between:				
		PLL_INPUT	PLL Input Source			
		0	MCLK			
		1	I2S_CLK			

The M divider should be set such that the output of the divider is between 0.5 MHz and 5 MHz. The division of the M divider is derived from PLL_M such that:

 $\mathsf{M} = \mathsf{PLL}_\mathsf{M} + 1$

Note 11: See Further Notes on PLL Programming for more detail.

12.6 PLL N DIVIDER CONFIGURATION REGISTER

This register is used to control the feedback divider of the PLL.

TABLE 7. PLL_N (0x03h)
Description

Bits	Field	Description				
7:0	PLL_N	Programs the PLL feedback divider as follows:				
		PLL_N	Feedback Divider Value			
		0 to 10	10			
		11	11			
		12	12			
		13	13			
		14	14			
		249	249			
		250 to 255	250			

The N divider should be set such that the output of the divider is between 0.5 MHz and 5 MHz. (Fin/M)*N will be the target resting VCO frequency, F_{VCO} . The N divider should be set such that 40 MHz < (Fin/M)*N < 60 MHz. Fin/M is often referred to as F_{comp} (comparison frequency) or F_{ref} (reference frequency), in this document F_{comp} is used.

The integer division of the N divider is derived from PLL_N such that:

For 9 < PLL_N < 251: N = PLL_N

Note 12: See Further Notes on PLL Programming for further details.

12.7 PLL P DIVIDER CONFIGURATION REGISTER

This register is used to control the output divider of the PLL.

TABLE	8. PI	_L_P	(0x04h)
-------	-------	------	---------

Bits	Field	Descrip	tion			
0	RSVD	RESERVED				
3:1	PLL_P	PLL_P	Output Divider Value			
		0002	1			
		0012	2			
		0102	3			
		0112	4			
		1002	5			
		1012	6			
		1102	7			
		1112	8			
6:4	Q_DIV	Programs the Q Divider (divides from an expected 12.000 MHz input).				
		Q_DIV	Divide Value			
		0002	2			
		0012	3			
		0102	4			
		0112	6			
		1002	8			
		1012	10			
		1102	12			
		1112	13			
7	RSVD	RESERVED				

The division of the P divider is derived from PLL_P such that:

$$P = PLL_P + 1$$

Note 13: See Further Notes on PLL Programming for more details.

12.8 PLL N MODULUS CONFIGURATION REGISTER

This register is used to control the modulation applied to the feedback divider of the PLL.

Bits	Field	Description		
4:0	PLL_N_MOD	Programs the PLL N divider's fractional component:		
		PLL_N_MOD	Fractional Addition	
		0	0/32	
		1	1/32	
		2 to 30	2/32 to 30/32	
		31	31/32	
6:5	DITHER_LEVEL	Allows control over the dither used by the N divider:		
		DITHER_LEVEL	Value	
		002	Medium	
		012	Small	
		102	Large	
		112	Off	
7	RSVD	RESERVED		

TABLE 9. PLL_N_MOD (0x05h)

The complete N divider is a fractional divider as such:

$$N = PLL_N + PLL_N_MOD/32$$

If the modulus input is zero then the N divider is simply an integer N divider. The output from the PLL is determined by the following formula:

$$F_{out} = (F_{in}*N)/(M*P)$$

Note 14: See Further Notes on PLL Programming for more details.

12.9 FURTHER NOTES ON PLL PROGRAMMING

The sigma-delta PLL is designed to drive audio circuits requiring accurate clock frequencies of up to 30 MHz with frequency errors noise-shaped away from the audio band. The 5 bits of modulus control provide exact synchronization of 48 kHz and 44.1 kHz sample rates from any common system clock. In systems where an isochronous I2S data stream is the source of data to the DAC a clock synchronous to the sample rate should be used as input to the PLL (typically the I2S clock). If no isochronous source is available then the PLL can be used to obtain a clock that is accurate to within 1 Hz of the correct sample rate although this is highly unlikely to be a problem.

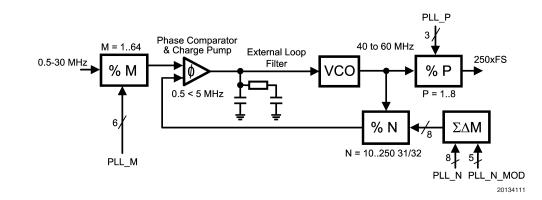


FIGURE 7. PLL Overview

					3				
F _{in} (MHz)	F _s (kHz)	М	N	Р	PLL_M	PLL_N	PLL_N_MOD	PLL_P	F _{out} (MHz)
11	48	11	60	5	10	60	0	4	12
12.288	48	4	19.53125	5	3	19	17	4	12
13	48	13	60	5	12	60	0	4	12
14.4	48	9	37.5	5	8	37	16	4	12
16.2	48	27	100	5	26	100	0	4	12
16.8	48	14	50	5	13	50	0	4	12
19.2	48	13	40.625	5	12	40	20	4	12
19.44	48	27	100	6	26	100	0	5	12
19.68	48	21	64.03125	5	20	64	1	4	12
19.8	48	17	51.5	5	16	51	16	4	12
11	44.1	11	55.125	5	10	55	4	4	11.025
11.2896	44.1	8	39.0625	5	7	39	2	4	11.025
12	44.1	5	22.96875	5	4	22	31	4	11.025
13	44.1	13	55.125	5	12	55	4	4	11.025
14.4	44.1	12	45.9375	5	11	45	30	4	11.025
16.2	44.1	9	30.625	5	8	9	20	4	11.025
16.8	44.1	17	55.78125	5	16	30	25	4	11.025
19.2	44.1	16	45.9375	5	15	45	30	4	11.025
19.44	44.1	14	39.6875	5	13	39	22	4	11.025
19.68	44.1	21	47.0625	4	20	47	2	3	11.025
19.8	44.1	11	30.625	5	10	30	204	4	11.025

TABLE 10. Example PLL Settings for 48 kHz and 44.1 kHz Sample Rates

These tables cover the most common applications, obtaining clocks for derivative sample rates such as 22.05 kHz should be done by increasing the P divider value or using the R/Q dividers.

If the user needs to obtain a clock unrelated to those described above, the following method is advised. An example of obtaining 12.000 MHz from 1.536 MHz is shown below (this is typical for deriving DAC clocks from I2S datastreams).

Choose a small range of P so that the VCO frequency is swept between 40 MHz and 60 MHz. So for P = 3 to 5, sweep the M inputs from 1 to 3. The most accurate N and N_MOD can be calculated by:

 $N = FLOOR(((Fout/Fin)^{*}(P^{*}M)), 1)$

 $N_MOD = ROUND(32^*(((Fout)/Fin)^*(P^*M)-N),0)$

This shows that setting M = 1, N = 39+1/16, P = 5 (i.e. PLL_M = 0, PLL_N = 39, PLL_N_MOD = 2, & PLL_P = 4) gives a comparison frequency of 1.5 MHz, a VCO frequency of 60 MHz and an output frequency of 12.000 MHz. The same settings can be used to get 11.025 from 1.4112 MHz for 44.1 kHz sample rates.

Care must be taken when synchronization of isochronous data is not possible, i.e. when the PLL has to be used but an exact frequency match cannot be found. The I2S should be master on the LM4935 so that the data source can support appropriate SRC as required. This method should only be used with data being read on demand to eliminate sample rate mismatch problems.

Where a system clock exists at an integer multiple of the required ADC or DAC clock rate it is preferable to use this rather than the PLL. The LM4935 is designed to work in 8, 12, 16, 24, 48 kHz modes from a 12 MHz clock and 8, 13, 26, 52 kHz modes from a 13 MHz clock without the use of the PLL. This saves power and reduces clock jitter which can affect SNR.

The actual ADC and DAC sample rates are set up by the PLL and internal clock dividers.

12.10 ADC_1 CONFIGURATION REGISTER

This register is used to control the LM4935's audio ADC.

TABLE 11. ADC_1 (0x06h)

			<i>)</i> ()			
Bits	Field	Description				
0	MIC_SELECT	If set the microphone preamp output is added	to the ADC input signal.			
1	CPI_SELECT	If set the cell phone input is added to the ADC	; input signal.			
2	LEFT_SELECT	If set the left stereo bus is added to the ADC i	nput signal.			
3	RIGHT_SELECT	If set the right stereo bus is added to the ADC	input signal.			
5:4	ADC_SAMPLE_	Programs the closest expected sample rate of the mono ADC, which is a variable required by the				
	RATE	AGC algorithm whenever the AGC is in use. This does not set the sample rate of the mono ADC.				
		ADC_SAMPLE_RATE Sample Rate				
		002	8 kHz			
		012	12 kHz			
		102	16 kHz			
		112	24 kHz			
7:6	HPF_MODE	Sets the HPF of the ADC				
		HPF-MODE	HPF Response			
		002	No HPF			
		012	F _S = 8 kHz, –0.5 dB @ 300 Hz, Notch @ 55 Hz			
			F _S = 12 kHz, –0.5 dB @ 450 Hz, Notch @ 82 Hz			
			F _S = 16 kHz, –0.5 dB @ 600 Hz, Notch @ 110 Hz			
		102	F _S = 8 kHz, -0.5 dB @ 150 Hz, Notch @ 27 Hz			
			F _S = 12 kHz, –0.5 dB @ 225 Hz, Notch @ 41 Hz			
			F _S = 16 kHz, –0.5 dB @ 300 Hz, Notch @ 55 Hz			
		112	No HPF			

12.11 ADC_2 CONFIGURATION REGISTER

This register is used to control the LM4935's audio ADC.

		TABLE 12. ADC_2 (0x07h)				
Bits	Field	Description				
0	ULAW/ALAW	If COMPAND is set then the data across the PCM interface to the DAC and from the ADC is companded as follows:				
		ULAW/ALAW	Commanding Type			
		0	μ-law			
		1	A-law			
1	COMPAND	If set the 16 bit PCM data from the ADC is compa data to the DAC is treated as companded data.	anded before the PCM interface and the PCM			
2	ADC_MUTE	If set the analog inputs to the ADC are muted.				
5:3	AGC_FRAME_TIME	This sets the frame time to be used by the AGC algorithm. In a given frame, the AGC's peak detector determines the peak value of the incoming microphone audio signal and compares this value to the target value of the AGC defined by AGC_TARGET (bits [3:1] of register (0x08h)) in order to adjust the microphone preamplifiers gain accordingly. AGC_FRAME_TIME basically sets the sample rate of the AGC to adjust for a wide variety of speech patterns. (Note 15)				
		AGC_FRAME_TIME	Time (ms)			
		0002	96			
		0012	128			
		0102	192			
		0112	256			
		1002	384			
		1012	512			
		1102	768			
		1112	1000			
6	ADC_I2S_M	If set the DAC clock system is enabled to drive th should be double that at Point C. This bit should be mode to read SAR information whenever both the	be set when using the I2S interface in master			
7	AUDIO_IF_2_16BIT	If set the PCM and I2S interfaces are 16 bits per word are 25% shorter to allow generation.	word in master mode. The 2 last clock cycles per			

Note 15: Refer to the AGC overview for further detail.

12.12 AGC_1 CONFIGURATION REGISTER

This register is used to control the LM4935's Automatic Gain Control. (Note 16)

TABLE 13. AGC_1 (0x08h)

		TABLE 13. AGC_1 (0x001)				
Bits	Field	Desc	ription			
0	AGC_ENABLE	If set the AGC controls the analog microphone preamplifier gain into the system. The microphone				
		input must be passed to the ADC.				
3:1	AGC_TARGET	Programs the target level of the AGC. This will depend on the expected transients and desired				
		headroom. Refer to AGC_TIGHT (bit 7 of 0x09h)	for more detail.			
		AGC_TARGET	Target Level			
		0002	-6 dB			
		0012	–8 dB			
		0102	-10 dB			
		0112	-12 dB			
		1002	-14 dB			
		1012	–16 dB			
		1102	–18 dB			
		1112	–20 dB			
4	NOISE_GATE_ON	If set, signals below the noise gate threshold are	muted.The noise gate is only activated after a set			
		period of signal absence.				
7:5	NOISE_	This field sets the expected background noise level relative to the peak signal level. The sole				
	GATE_	presence of signals below this level will not result in an AGC gain change of the input and will be				
	THRES	gated from the ADC output if the NOISE_GATE_ON is set. This level must be set even if the noise				
		gate is not in use as it is required by the AGC algorithm.				
		NOISE_GATE_THRES	Level			
		0002	-72 dB			
		0012	-66 dB			
		0102	-60 dB			
		0112	–54 dB			
		1002	-48 dB			
		1012	-42 dB			
		1102	-36 dB			
		1112	-30 dB			

Note 16: See the AGC overview.

12.13 AGC_2 CONFIGURATION REGISTER

This register is used to control the LM4935's Automatic Gain Control.

LM4935

Bits	Field		Description				
3:0	AGC_MAX_GAIN	-					
		AGC_MAX_GAIN Max Preamplifier Gain					
		00002	6 d				
		00012	8 d	8 dB			
		0010 ₂ 10 dB					
		00112	12 0	dB			
		0100 ₂ to 1100 ₂	14 dB to) 30 dB			
		11012	32 0	dB			
		11102	34 0	dB			
		11112	36 0	dB			
6:4	AGC_DECAY	Programs the speed at which the A signal.	AGC will increase gains if it detect	ts the input level is a quiet			
		AGC_DECAY	Step Tim	ne (ms)			
		0002	32	2			
		0012	64	1			
		0102	12	8			
		0112	25	6			
		1002	51	2			
		101 ₂	102	24			
		110 ₂	204	18			
		111 ₂	409	96			
7	AGC_TIGHT	If set the AGC algorithm controls the	ne microphone preamplifier more	exactly. (Note 17)			
	AGC_TIGHT = 0	AGC_TARGET	Min Level	Max Level			
		0002	–6 dB	–3 dB			
		0012	–8 dB	–4 dB			
		0102	–10 dB	–5 dB			
		0112	–12 dB	–6 dB			
		1002	–14 dB	–7 dB			
		101 ₂	–16 dB	–8 dB			
		1102	–18 dB	–9 dB			
		1112	–20 dB	–10 dB			
	AGC_TIGHT = 1	0002	–6 dB	–3 dB			
		0012	–8 dB	–5 dB			
		0102	-10 dB	–7 dB			
		0112	–12 dB	–9 dB			
		1002	–14 dB	–11 dB			
		101 ₂	–16 dB	–13 dB			
		110 ₂	–18 dB	–15 dB			
		111 ₂	–20 dB	–17 dB			

Note 17: The AGC can be used to control the analog path of the microphone to the output stages or to optimize the microphone path for recording on the ADC. When the analog path is used this bit should be set to ensure the target is tightly adhered to. If the ADC is the only destination of the microphone or the desired analog mixer level is line level then AGC_TIGHT should be cleared, allowing greater dynamic rage of the recorded signal. For further details see the AGC overview.

12.14 AGC_3 CONFIGURATION REGISTER

This register is used to control the LM4935's Automatic Gain Control. (Note 18)

TABLE 15. AGC_3 (0x0Ah)

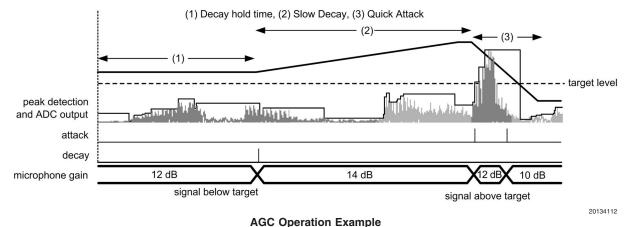
Bits Field Description 4:0 AGC_HOLDTIME Programs the amount of delay before the AGC algorithm begins to adjust the gain of the microphone preamplifier. AGC_HOLDTIME AGC_HOLDTIME No. of speech segments 000002 0 000012 1	
microphone preamplifier. AGC_HOLDTIME No. of speech segments 000002 0	
AGC_HOLDTIME No. of speech segments 000002 0	
000002 0	
000012 1	
000102 2	
000112 3	
00100 ₂ to 11100 ₂ 4 to 28	
11101 ₂ 29	
11110 ₂ 30	
11111 ₂ 31	
7:5 AGC_ATTACK Programs the speed at which the AGC will reduce gains if it detects the input level is too la	ge.
AGC_ATTACK Step Time (ms)	
000 ₂ 32	
0012 64	
010 ₂ 128	
011 ₂ 256	
100 ₂ 512	
101 ₂ 1024	
110 ₂ 2048	
1112 4096	

Note 18: See the AGC overview.

12.15 AGC OVERVIEW

The Automatic Gain Control (AGC) system can be used to optimize the dynamic range of the ADC for voice data when the level of the source is unknown. A target level for the output is set so that any transients on the input won't clip during normal operation. The AGC circuit then compares the output of the ADC to this level and increases or decreases the gain of the microphone preamplifier to compensate. If the audio from the microphone is to be output digitally through the ADC then the full dynamic range of the ADC can be used automatically. If the output is through the analog mixer then the ADC is used to monitor the microphone level. In this case, the analog dynamic range is less important than the absolute level, so *AGC_TIGHT* should be set to tie transients closely to the target level.

To ensure that the system doesn't reduce the quality of the speech by constantly modulating the microphone preamplifier gain, the ADC output is passed through an envelope detector. This frames the output of the ADC into time segments roughly equal to the phonemes found in speech (AGC_FRAME_TIME). To calculate this, the circuit must also know the sample rate of the data from the ADC (ADC_SAMPLERATE). If after a programmable number of these segments (AGC_HOLDTIME), the level is consistently below target, the gain will be increased at a programmable rate (AGC_DECAY). If the signal ever exceeds the target level (AGC_TARGET) then the gain of the microphone is reduced immediately at a programmable rate (AGC_ATTACK). This is demonstrated below:



The signal in the above example starts with a small analog input which, after the hold time has timed out, triggers a rise in the gain $((1) \rightarrow (2))$. After some time the real analog input increases and it reaches the threshold for a gain reduction which decreases the gain at a faster rate $((2) \rightarrow (3))$ to allow the elimination of typical popping noises.

Only ADC outputs that are considered signal (rather than noise) are used to adjust the microphone preamplifier gain. The signal to noise ratio of the expected input signal is set by *NOISE_GATE_THRESHOLD*. In some situations it is preferable to remove audio considered to be consisting solely of background noise from the audio output; for example conference calls. This can be done by setting *NOISE_GATE_ON*. This does not affect the performance of the AGC algorithm.

The AGC algorithm should not be used where very large background noise is present. If the type of input data, application and microphone is known then the AGC will typically not be required for good performance, it is intended for use with inputs with a large dynamic range or unknown nominal level. When setting *NOISE_GATE_THRESHOLD* be aware that in some mobile phone scenarios the ADC SNR will be dictated by the microphone performance rather than the ADC or the signal. Gain changes to the microphone are performed on zero crossings. To eliminate DC offsets, wind noise, and pop sounds from the output of the ADC, the ADC's HPF should always be enabled.

12.16 MIC_1 CONFIGURATION REGISTER

This register is used to control the microphone configuration.

TABLE 16. MIC_1 (0x0Bh)

Bits	Field	Description			
3:0	PREAMP_GAIN	Programs the gain applied to the microphone preamplifier if the AGC is not in use.			
		PREAMP_GAIN	Gain		
		00002	6 dB		
		00012	8 dB		
		00102	10 dB		
		00112	12 dB		
		0100 ₂ to 1100 ₂	14 dB to 30 dB		
		1101 ₂	32 dB		
		11102	34 dB		
		11112	36 dB		
4	MIC_MUTE	If set the microphone preamplifier is muted.			
5	INT_SE_DIFF	If set the internal microphone is assumed to be single ended and the negative connection is			
		connected to the ADC common mode point intern	nally. This allows a single-ended internal		
		microphone to be used.			
6	INT_EXT	If set the single ended external microphone is used and the negative microphone input is grounded			
		internally, otherwise internal microphone operation	n is assumed. (Note 19)		

Note 19: On changing INT_EXT from internal to external note that the dc blocking cap will not be charged so some time should be taken (300 ms for a 1 µF cap) between the detection of an external headset and the switching of the output stages and ADC to that input to allow the DC points on either side of this cap to stabilize. This can be accomplished by deselecting the microphone input from the audio outputs and ADC until the DC points stabilize.

An active MIC path to CPOUT or the ADC may result in the microphone DC blocking caps causing audio pops under the following situations:

1) Switching between internal and external microphone operation while in chip modes '10' or '11'.

2) Toggling in and out of powerdown/standby modes.

3) Toggling between chip modes '10' and '11' whenever external microphone operation is selected.

4) The insertion/removal of a headset while in chip modes '10' or '11' whenever external microphone operation is selected.

To avoid these potential pop issues, it is recommended to deselect the microphone input from CPOUT and ADC until the DC points stabilize.

12.17 MIC_2 CONFIGURATION REGISTER

This register is used to control the microphone configuration.

		TABLE 17.	MIC_2 (0x0Ch)	
Bits	Field	Description		
0	OCL_	Selects the voltage used as virtual ground (HP_VMID pin) in OCL mode. This will depend on the		
	VCM_	available supply and the power output requirements of the headphone amplifiers.		
	VOLTAGE	OCL_VCM_VOLTAGE	Volt	age
		0	1.:	2V
		1	1.	5V
2:1	MIC_	Selects the voltage as a reference	e to the internal and external micro	ophones. Only one bias pin is
	BIAS_	driven at once depending on the	INT_EXT bit setting found in the N	/IC_1 (0x0Bh) register.
	VOLTAGE		set to '11' only if $A_V_{DD} > 3.4V$. Ir	
			Γ_BIAS = 2.0V) should not be use	•
		supply for a cellular headset external microphone. Please refer to Table 18 for mo		
		MIC_BIAS_VOLTAGE	EXT_BIAS	INT_BIAS
		002	2.0V	2.0V
		012	2.5V	2.5V
		102	2.8V	2.8V
		112	3.3V	3.3V
3	BUTTON_TYPE	If set the LM4935 assumes that the button (if used) in the headset is in series (series push button)		
			circuit when pressed. The default	is for the button to be in parallel
		(parallel push button), shorting ou	· ·	
5:4	BUTTON_	Sets the time used for debouncing the pushing of the button on a headset with a parallel push		
	DEBOUNCE_	button.		
	TIME	BUTTON_DEB	OUNCE_TIME	Time (ms)
		00) ₂	0
		0.	1 ₂	8
		10	D ₂	16
		1.	1 ₂	32

In OCL mode there is a trade-off between the external microphone supply voltage (EXT_MIC_BIAS - OCL_VCM_ VOLTAGE) and the maximum output power possible from the headphones. A lower OCL_VCM_VOLTAGE gives a higher microphone supply voltage but a lower maximum output power from the headphone amplifiers due to the lower OCL_VCM_VOLTAGE - A_V_{SS}.

TABLE 18. External MIC	Supply Voltages	in OCL Mode
------------------------	-----------------	-------------

Available	Recommended	Supply to Microphone		
A_V_{DD}	EXT_MIC_BIAS	OCL_VCM_VOLT = 1.5V	OCL_VCM_VOLT = 1.2V	
> 3.4V	3.3V	1.8V	2.1V	
2.9V to 3.4V	2.8V	1.3V	1.6V	
2.8V to 2.9V	2.5V	1.0V	1.3V	
2.7V to 2.8V	2.5V	-	1.3V	

12.18 SIDETONE ATTENUATION REGISTER

This register is used to control the analog sidetone attenuation. (Note 20)

TABLE 19. SIDETONE (0x0Dh)

Bits	Field	Description		
3:0	SIDETONE_	Programs the attenuation applied to the microphone preamp output to produce a sidetone signal.		
	ATTEN	SIDETONE_ATTEN	Attenuation	
		00002	-Inf	
		00012	–30 dB	
		0010 ₂	–27 dB	
		0011 ₂	–24 dB	
		01002	–21 dB	
		0101 ₂ to 1010 ₂	–18 dB to –3 dB	
		1011 ₂ to 1111 ₂	0 dB	

Note 20: An active SIDETONE path to an audio output may result in the microphone DC blocking caps causing audio pops under the following situations: 1) Switching between internal and external microphone operation while in chip modes '10' or '11'.

2) Toggling in and out of powerdown/standby modes.

3) Toggling between chip modes '10' and '11' whenever external microphone operation is selected.

4) The insertion/removal of a headset while in chip modes '10' or '11' whenever external microphone operation is selected.

To avoid potential pop noises, it is recommended to set SIDETONE_ATTEN to '0000' until DC points have stabilized whenever the SIDETONE path is used.

12.19 CP_INPUT CONFIGURATION REGISTER

This register is used to control the differential cell phone input.

Bits	Field	Description	
4:0	CPI_LEVEL	Programs the gain/attenuation applied to the cell phone input.	
		CPI_LEVEL	Level
		000002	–34.5 dB
		000012	–33 dB
		000102	–31.5 dB
		000112	–30 dB
		00100 to 11100 ₂	-28.5 dB to +7.5 dB
		111012	+9 dB
		111102	+10.5 dB
		111112	+12 dB
5	CPI_MUTE	If set the CPI input is muted at source.	

12.20 AUX_LEFT CONFIGURATION REGISTER

This register is used to control the left aux analog input.

TABLE 21. AUX	_LEFT (0x0Fh)
---------------	---------------

Bits	Field	Description		
4:0	AUX_	Programs the gain/attenuation applied to the AUX LEFT analog input to the mixer. (Note 21)		
	LEFT_	AUX_LEFT_LEVEL	Level (With Boost)	Level (Without Boost)
	LEVEL	00000 ₂	–34.5 dB	-46.5 dB
		000012	–33 dB	–45 dB
		00010 ₂	–31.5 dB	-43.5 dB
		000112	–30 dB	–42 dB
		00100 to 11100 ₂	-28.5 dB to +7.5 dB	-40.5 dB to -4.5 dB
		11101 ₂	+9 dB	–3 dB
		11110 ₂	+10.5 dB	–1.5 dB
		11111 ₂	+12 dB	0 dB
5	AUX_	If set the gain of the AUX_LEFT	input to the mixer is increased by	12 dB (see above).
	LEFT_			
	BOOST			
6	AUX_L_MUTE	If set the AUX LEFT input is muted.		
7	AUX_OR_DAC_L	If set the AUX LEFT input is passed to the mixer, the default is for the DAC LEFT output to be		
		passed to the mixer.		

Note 21: The recommended mixer level is 1V RMS. The auxiliary analog inputs can be boosted by 12 dB if enough headroom is available. Clipping may occur if the analog power supply is insufficient to cater for the required gain.

12.21 AUX_RIGHT CONFIGURATION REGISTER

This register is used to control the right aux analog input.

TABLE 22. AUX_RIGHT (0x10h)				
Bits	Field	Description		
4:0	AUX_	Programs the gain/attenuation ap	plied to the AUX RIGHT analog in	put to the mixer. (Note 22)
	RIGHT_	AUX_RIGHT_LEVEL	Level (With Boost)	Level (Without Boost)
	LEVEL	000002	–34.5 dB	-46.5 dB
		000012	–33 dB	–45 dB
		000102	–31.5 dB	–43.5 dB
		000112	–30 dB	-42 dB
		00100 to 11100 ₂	-28.5 dB to +7.5 dB	-40.5 dB to -4.5 dB
		111012	+9 dB	–3 dB
		11110 ₂	+10.5 dB	–1.5 dB
		111112	+12 dB	0 dB
5	AUX_	If set the gain of the AUX_RIGHT input to the mixer is increased by 12 dB (see above).		
	RIGHT_BOOST			
6	AUX_R_MUTE	If set the AUX RIGHT input is muted.		
7	AUX_OR_DAC_R	If set the AUX RIGHT input is passed to the mixer, the default is for the DAC RIGHT output to be		
		passed to the mixer.		

Note 22: The recommended mixer level is 1V RMS. The auxiliary analog inputs can be boosted by 12 dB if enough headroom is available. Clipping may occur if the analog power supply is insufficient to cater for the required gain.

12.22 DAC CONFIGURATION REGISTER

This register is used to control the DAC levels to the mixer.

	TABLE 23. DAC (0x11h)				
Bits	Field	Description			
4:0	DAC_LEVEL	Programs the gain/attenuation applied to the DAC input to the mixer. (Note 23)			
		DAC_LEVEL	Level (With Boost)	Level (Without Boost)	
		000002	–34.5 dB	-46.5 dB	
		000012	–33 dB	–45 dB	
		000102	–31.5 dB	-43.5 dB	
		000112	–30 dB	-42 dB	
		00100 to 11100 ₂	-28.5 dB to +7.5 dB	-40.5 dB to -4.5 dB	
		111012	+9 dB	–3 dB	
		111102	+10.5 dB	–1.5 dB	
		111112	+12 dB	0 dB	
5	USE_AUX_	If set the gain of the DAC inputs is controlled by the AUX_LEFT and AUX_RIGHT registers, allowing			
	LEVELS	a stereo balance to be applied.			
6	BOOST	If set the gain of the DAC inputs to the mixer is increased by 12 dB (see above).			
7	DAC_MUTE	If set the stereo DAC input is mu	If set the stereo DAC input is muted on the next zero crossing.		

Note 23: The output from the DAC is 1V RMS for a full scale digital input. This can be boosted by 12 dB if enough headroom is available. Clipping may occur if the analog power supply is insufficient to cater for the required gain.

12.23 CP_OUTPUT CONFIGURATION REGISTER

This register is used to control the differential cell phone output. (Note 24)

TABLE 24. CP_OUTPUT (0x12h)

Bits	Field	Description	
0	MIC_SELECT	If set the microphone channel of the mixer is added to the cellphone output signal.	
1	RIGHT_SELECT	f set the right channel of the mixer is added to the cellphone output signal.	
2	LEFT_SELECT	If set the left channel of the mixer is added to the cellphone output signal.	
3	CPO_MUTE	If set the CPOUT output is muted.	
4	MIC_NOISE_GATE	If this is set and NOISE_GATE_ON (register 0x08h) is enabled, the MIC to CPO path will be	
		gated if the signal is determined to be noise by the AGC (that is, if the signal is below the set	
		noise threshold).	

Note 24: The gain of cell phone output amplifier is 0 dB.

12.24 AUX_OUTPUT CONFIGURATION REGISTER

This register is used to control the differential auxiliary output. (Note 25)

TABLE 25. AUX_OUTPUT (0x13h)

Bits	Field	Description
0	CPI_SELECT	If set the cell phone input channel of the mixer is added to the aux output signal.
1	RIGHT_SELECT	If set the right channel of the mixer is added to the aux output signal.
2	LEFT_SELECT	If set the left channel of the mixer is added to the aux output signal.
3	AUX_MUTE	If set the aux output is muted.

Note 25: The gain of the auxiliary output amplifier is 0 dB. If a second (external) loudspeaker amplifier is to be used its gain should be set to 12 dB to match the onboard loudspeaker amplifier gain.

12.25 LS_OUTPUT CONFIGURATION REGISTER

This register is used to control the loudspeaker output. (Note 26)

TABLE 26. LS_OUTPUT (0x14h)

Bits	Field	Description
0	CPI_SELECT	If set the cell phone input channel of the mixer is added to the loudspeaker output signal.
1	RIGHT_SELECT	If set the right channel of the mixer is added to the loudspeaker output signal.
2	LEFT_SELECT	If set the left channel of the mixer is added to the loudspeaker output signal.
3	LS_MUTE	If set the loudspeaker output is muted.

Note 26: The gain of the loudspeaker output amplifier is 12 dB.

12.26 HP_OUTPUT CONFIGURATION REGISTER

This register is used to control the stereo headphone output. (Note 27)

TABLE 27. HP_OUTPUT (0x15h)

	1	
Bits	Field	Description
0	SIDETONE_SELECT	If set the sidetone channel of the mixer is added to both of the headphone output signals.
1	CPI_SELECT	If set the cell phone input channel of the mixer is added to both of the headphone output signals.
2	RIGHT_SELECT	If set the right channel of the mixer is added to the headphone output. If the STEREO bit (0x00h) is set, the right channel is added to the right headphone output signal only. If the STEREO bit (0x00h) is cleared, it is added to both the right and left headphone output signals.
3	LEFT_SELECT	If set the left channel of the mixer is added to the headphone output. If the STEREO bit (0x00h) is set, the left channel is added to the left headphone output signal only. If the STEREO bit (0x00h) is cleared, it is added to both the right and left headphone output signals.
4	HP_MUTE	If set the headphone output is muted.

Note 27: The gain of the headphone output amplifier is $-6 \, dB$ for the cell phone input channel and sidetone channel of the mixer. When the STEREO bit (0x00h) is set, headphone output amplifier gain is $-6 \, dB$ for the left and right channel. When the STEREO bit (0x00h) is cleared, the headphone output amplifier gain is $-12 \, dB$ for the left and right channel (to allow enough headroom for adding them and routing them to both headphone amplifiers).

12.27 EP_OUTPUT CONFIGURATION REGISTER

This register is used to control the mono earpiece output. (Note 28)

TABLE 28. EP_OUTPUT (0x16h)

Bits	Field	Description
0	SIDETONE_SELECT	If set the sidetone channel of the mixer is added to the earpiece output signal.
1	CPI_SELECT	If set the cell phone input channel of the mixer is added to the earpiece output signal.
2	RIGHT_SELECT	If set the right channel of the mixer is added to the earpiece output signal.
3	LEFT_SELECT	If set the left channel of the mixer is added to the earpiece output signal.
4	EP_MUTE	If set the earpiece output is muted.

Note 28: The gain of the earpiece output amplifier is 6 dB.

12.28 DETECT CONFIGURATION REGISTER

This register is used to control the headset detection system.

TABLE 29. DETECT (0x17h)

Bits	Field	Desci	ription	
0	DET_INT	If set an IRQ is raised when a change is detected in the headset status. Clearing		
		an IRQ that has been triggered by the headset de	etect.	
1	BTN_INT	If set an IRQ is raised when the headset button is	s pressed. Clearing this bit will clear an IRQ that	
		has been triggered by a button event.		
2	TEMP_INT	If set an IRQ is raised during a temperature even	· · · · · · · · · · · · · · · · · · ·	
		cycle the power amplifiers off if the internal tempe	•	
		whenever the loudspeaker amplifier is turned on.	Clearing this bit will clear an IRQ that has been	
		triggered by a temperature event.		
6:3	HS_	Sets the time used for debouncing the analog sig	nals from the detection inputs used to sense the	
	DBNC_TIME	insertion/removal of a headset.		
		HS_DBNC_TIME	Time (ms)	
		00002	0	
		00012	8	
		00102	16	
		00112	32	
		01002	48	
		01012	64	
		01102	96	
		01112	128	
		10002	192	
		10012	256	
		10102	384	
		10112	512	
		11002	768	
		11012	1024	
		11102	1536	
		11112	2048	

12.29 HEADSET DETECT OVERVIEW

The LM4935 has built in monitors to automatically detect headset insertion or removal. The detection scheme can differentiate between mono, stereo, mono-cellular and stereo-cellular headsets. Upon detection of headset insertion or removal, the LM4935 updates read-only bit 0 - headset absence/presence, bit 1- mono/stereo headset and bit 2 - headset without mic / with mic, of the STATUS register (0x18h). Headset insertion/removal and headset type can also be detected in standby mode; this consumes no analog supply current when the headset is absent.

The LM4935 can be programmed to raise an interrupt (set the IRQ pin high) when headset insert/removal is sensed by setting bit 0 of DETECT (0x17h). When headset detection is enabled in active mode and a headset is not detected, the HPL_OUT and HPR_OUT amplifiers will be disabled (switched off for capless mode and muted for AC-coupled mode) and the EXT_BIAS pin will be disconnected from the MIC_BIAS amplifier, irrespective of control register settings.

The LM4935 also has the capability to detect button press, when a button is present on the headset microphone. Both parallel button-type (in parallel with the headset microphone, default value) and series button-type (in series with the headset microphone) can be detected; the button type used needs to be defined in bit 3 of MIC_2 (0x0Ch). Button press can also be detected in stand-by mode; this consumes 10 μ A of analog supply current for a series type push button and 100 μ A for a parallel type push button. Upon button press, the LM4935 updates bit 3 of STATUS (0x18h). In active OCL mode, with internal microphone selected (INT_EXT = 0; (reg 0x0Bh)), if a parallel pushbutton headset is inserted into the system, INT_EXT must be set high before BTN (bit 3 of STATUS (0x18h)) can be read. The LM4935 can also be programmed to raise an interrupt on the IRQ pin when button press is sensed by setting bit 1 of DETECT.

The LM4935 provides debounce programmability for headset and button detect. Debounce programmability can be used to reject glitches generated, and hence avoid false detection, while inserting/removing a headset or pressing a button.

Headset insert/removal debounce time is defined by HS_DBNC_TIME; bits 6:3 of DETECT (0x17h). Parallel button press debounce time is defined by BTN_DBNC_TIME; bits 5:4 of MIC_2 (0x0Ch).

Note that since the first effect of a series button press (microphone disconnected) is indistinguishable from headset removal, the debounce time for series button press in defined by HS_DBNC_TIME.

Headset and push button detection can be enabled by setting CHIP_MODE 0; bit 0 of BASIC (0x00h). For reliable headset / push button detection all following bits should be defined before enabling the headset detection system:

1) the OCL-bit (AC-Coupled / Capless headphone interface (bit 7 of BASIC (0x00h))

2) the headset insert/removal debounce settings (bit 6:3 of DETECT (0x17h))

3) the BTN_TYPE-bit (Parallel / Series push button type (bit 3 of MIC_2 (0x0Ch))

4) the parallel push button debounce settings (bit 5:4 of MIC_2 (0x0Ch))

Figure 8 shows terminal connections and jack configuration for various headsets. Care should be taken to avoid any DC path from the MIC_DET pin to ground when a headset is not inserted.

LM4935

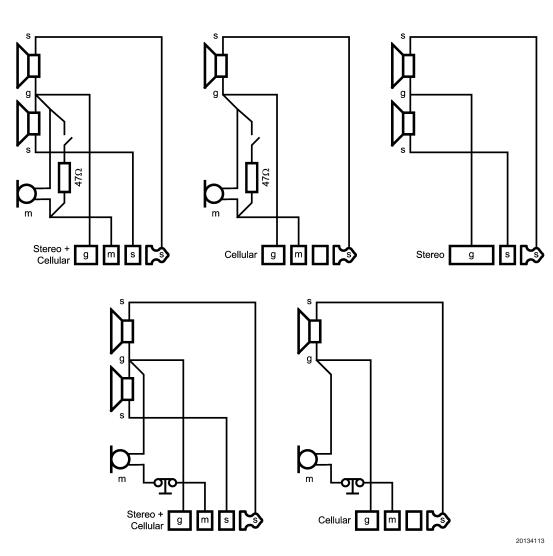
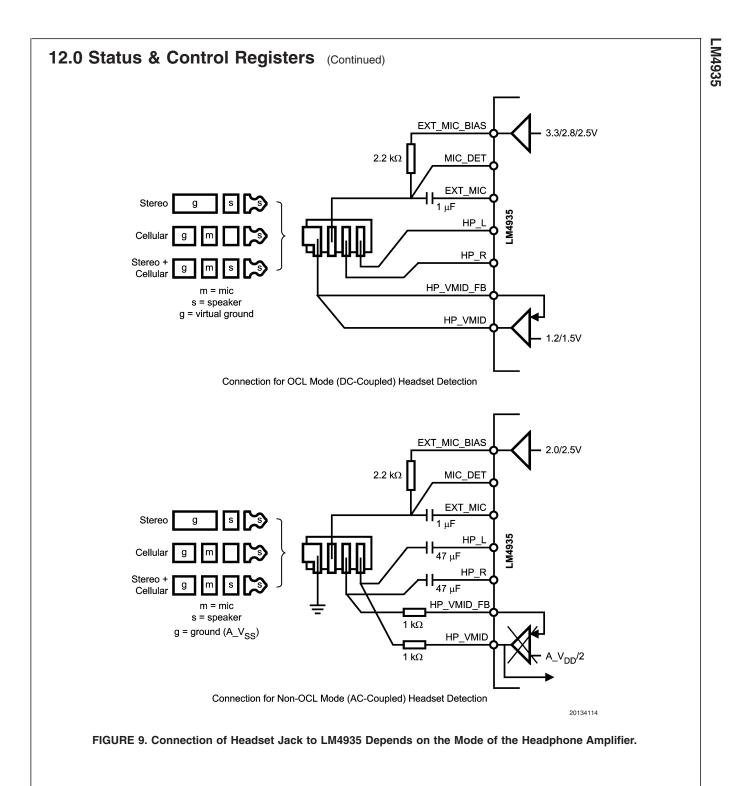


FIGURE 8. Headset Configurations Supported by the LM4935

The wiring of the headset jack to the LM4935 will depend on the intended mode of the headphone amplifier:



12.30 STATUS REGISTER

This register is used to report the status of the device.

TABLE 30. STATUS (0x18h)

Bits	Field	Description
0	HEADSET	This field is high when headset presence is detected (only valid if the detection system is enabled). (Note 29)
1	STEREO_ HEADSET	This field is high when a headset with stereo speakers is detected (only valid if the detection system is enabled). (Note 29)
2	MIC	This field is high when a headset with a microphone is detected (only valid if the detection system is enabled). (Note 29)
3	BTN	This field is high when the button on the headset is pressed (only valid if the detection system is enabled). IRQ is cleared when the button has been released and this register has been written to.
4	SAR TRIG 1	If this field is high then an event has happened on SAR trigger 1 (write to this register to clear IRQ).
5	SAR TRIG 2	If this field is high then an event has happened on SAR trigger 2 (write to this register to clear IRQ).
6	TEMP	If this field is high then a temperature event has occurred (write to this register to clear IRQ). This field will stay high even when the IRQ is cleared so long as the event occurs. This bit is only valid whenever the loudspeaker amplifier is turned off.
7	GPIN	When GPIO_SEL is set to a readable configuration a digital input on GPIO1 can be read back here.

Note 29: The detection IRQ is cleared when this register has been written to.

12.31 AUDIO INTERFACE CONFIGURATION REGISTER

This register is used to control the configuration of the audio data interfaces.

Field	Description						
AUDIO_IF_MODE	Selects the function of	of the 6 audio	interface IOs	6.			
	AUDIO_IF_MODE	12S_	I2S_	I2S_	I2S_	GPIO_1	GPIO_2
		CLK pin	WS pin	SDI pin	SDO pin	pin	pin
	002	l ² S	l ² S	l ² S	l ² S	GPIO	GPIO
		CLK	WS	SDI	SDO	1	2
	012	PCM	PCM	-	PCM	GPIO	GPIO
		CLK	SYNC		SDO	1	2
	10 ₂	PCM	PCM	PCM	PCM	GPIO	GPIO
		CLK	SYNC	SDI	SDO	1	2
	11 ₂	l ² S	l ² S	l ² S	PCM	PCM	PCM
		CLK	WS	SDI	SDO	CLK	SYNC
I2S_WS_MS	If set the I ² S_WS is	produced by t	the LM4935 a	nd the I ² S_W	S pin will be a	an output.	
I2S_CLK_MS	If set the I ² S_CLK is	produced by	the LM4935 a	and the I ² S_C	LK pin will be	an output.	
PCM_SYNC_MS	If set the PCM_SYN	C is produced	by the LM49	35 and the re	levant pin will	be an output.	
PCM_CLK_MS	If set the PCM_CLK	is produced b	y the LM4935	5 and the relev	vant pin will b	e an output.	
I2S_SDO_DATA	The two ADCs on the	e LM4935 car	n both be read	d via the isoch	ironous I2S in	terface. The n	nost recent
	valid sample is outpu	It from the fol	lowing source	: (Please refe	r to the GPIO	configuration	register
	(0x1Ah) for more info	ormation on S	AR_CH_SEL))			
	I2S_S	SDO_DATA		LE	FT	RIG	GHT
		002		AUDIO	D ADC	SAR_C	H_SEL
		012		SAR V	/SAR 1	SAR_C	H_SEL
		10 ₂		SAR V	/SAR 2	SAR_C	H_SEL
		11 ₂		A_V	/ _{DD} /2	SAR_C	H_SEL
	AUDIO_IF_MODE	AUDIO_IF_MODE Selects the function of AUDIO_IF_MODE AUDIO_IF_MODE 002 002 012 102 112 12S_WS_MS If set the I²S_WS is I2S_CLK_MS If set the I²S_CLK is PCM_SYNC_MS If set the PCM_SYNG PCM_CLK_MS If set the PCM_CLK I2S_SDO_DATA The two ADCs on the valid sample is output (0x1Ah) for more information)	FieldSelects the function of the 6 audioAUDIO_IF_MODE $I2SAUDIO_IF_MODEI2SAUDIO_IF_MODEI2SCLK pin00_2I^2SCLK01_2PCMCLK10_2PCMCLK11_2I^2SCLK11_2I^2SCLK11_2I^2SCLK11_2I^2SCLKIf set the I^2S_WS is produced byI2S_CLK_MSIf set the I^2S_CLK is produced byPCM_SYNC_MSIf set the PCM_SYNC is produced byPCM_CLK_MSIf set the PCM_CLK is produced byI2S_SDO_DATAThe two ADCs on the LM4935 carvalid sample is output from the fol(0x1Ah) for more information on SI2S_SDO_DATA00_201_210_2$	FieldDeAUDIO_IF_MODESelects the function of the 6 audio interface IOs $AUDIO_IF_MODE$ $I2S_$ $I2S_$ $AUDIO_IF_MODE$ $I2S_$ $I2S_$ $AUDIO_IF_MODE$ $I2S_$ $I2S_$ CLK pinWS pin 00_2 I^2S I^2S 00_2 I^2S $I^2S_$ 01_2 PCMPCM 01_2 PCMPCM 10_2 PCMPCM 11_2 $I^2S_$ $I^2S_$ 11_2 $I^2S_$ $I^2S_$ $I2S_WS_MS$ If set the I^2S_WS is produced by the LM4935 a $I2S_CLK_MS$ If set the I^2S_CLK is produced by the LM4935 a $I2S_SDO_DATA$ If set the PCM_CLK is produced by the LM4935 $I2S_SDO_DATA$ The two ADCs on the LM4935 can both be read $Valid sample is output from the following source00_200_201_210_210_2$	FieldDescriptionAUDIO_IF_MODESelects the function of the 6 audio interface IOs.AUDIO_IF_MODEI2S_I2S_AUDIO_IF_MODEI2S_I2S_I2S_I2S_AUDIO_IF_MODEI2S_I2S_I2S_I2S_OO2I^2SI^2SI^2SI^2SI^2SOO2I^2SI^2SI^2SI^2SI2S_OO2I12PCMPCMO12PCMPCMPCM-I02PCMPCMPCMI12I^2SI^2SI^2SI2S_WS_MSIf set the I^2S_WS is produced by the LM4935 and the I^2S_WI2S_CLK_MSIf set the I^2S_CLK is produced by the LM4935 and the I^2S_CPCM_SYNC_MSIf set the PCM_SYNC is produced by the LM4935 and the relevant of the two ADCs on the LM4935 can both be read via the isoch valid sample is output from the following source: (Please refere (0x1Ah) for more information on SAR_CH_SEL)I2S_SDO_DATALEI2S_SDO_DATALEI2S_SDO_DATALEI2S_SDO_DATALEI2S_SDO_DATALEI2S_SDO_DATALEI2S_SDO_DATALEI2S_SDO_DATALEI2S_SDO_DATALEI2S_SDO_DATALEI2S_SDO_DATALEI2S_SDO_DATALEI2S_SDO_DATALEI2S_SDO_DATALEI2S_SDO_DATALEI2S_SDO_DATALEI2S_SDO_DATALEI2S_SDO_DATALEI	Field Description AUDIO_IF_MODE Selects the function of the 6 audio interface IOs. I2S_ I2S_ <thi2s_< th=""> <thi2s_< th=""> I2S</thi2s_<></thi2s_<>	Field Description AUDIO_IF_MODE Selects the function of the 6 audio interface IOs. AUDIO_IF_MODE I2S_ I2S_ I2S_ GPIO_1 002 I2S I2S I2S GPIO_1 002 I2S I2S I2S GPIO_1 002 I2S I2S I2S GPIO 012 PCM PCM - PCM GPIO 012 PCM PCM - PCM GPIO 102 PCM PCM PCM GPIO 1 112 I2S I2S I2S PCM PCM 1112 I2S I2S I2S PCM PCM 12S_SUS_MS If set the I2S_WS is produced by the LM4935 and the I2S_WS in will be an output. I2S_CLK_MS If set the I2S_CLK is produced by the LM4935 and the I2S_CLK pin will be an output. PCM_SYNC_MS If set the PCM_CLK is produced by the LM4935 and the relevant pin will be an output. I2S_SDO_DATA The two ADCs on the LM4935 can both be read via the isochronous I2S interface. The r valid sample is output from the following source: (Please refer to t

TABLE 31. AUDIO_IF (0x19h)

12.32 DIGITAL AUDIO DATA FORMATS

I2S master mode can only be used when the DAC is enabled unless the ADC_I2S_M bit is set. PCM Master mode can only be used when the ADC is enabled. If the PCM receiver interface is operated in slave mode the clock and sync should be enabled at the same time as the PCM receiver uses the first PCM frame to calculate the PCM interface format. This format can not be changed unless a soft reset is issued. It is strongly recommended that the LM4935 is operated in master mode as this eliminates the risk of sample rate mismatch between the data converters and the audio interfaces.

In master mode the I2S_CLK has a 60/40 duty cycle and a frequency of 50*fs. In slave mode the PCM and I2S receivers only record the 1st 16 and 18 bits of the serial words respectively. The I2S format is as follows:

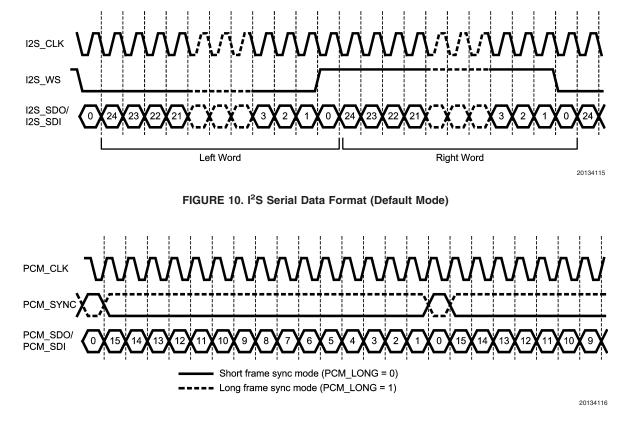


FIGURE 11. PCM Serial Data Format (16 bit Slave Example)

When SAR SDO data is passed to the I2S, it is left aligned (MSB aligned) to allow lower I2S resolutions to be used. If the DAC is driven from the PCM interface then the left channel of the DAC is used and the right channel is inactive.

12.33 GPIO CONFIGURATION REGISTER

This register is used to control the GPIO system.

Bits	Field	Description			
2:0	GPIO_SEL	This sets the function of the GPIOs when the Audio Interface is not using them.			
		GPIO_SEL	GPIO 1	GPIO 2	
		0002	0	0	
		0012	READABLE	SPI_SDO	
		0102	LS_AMP_ENABLE	SPI_SDO	
		0112	GPIO_DATA	SPI_SDO	
		100 ₂	0	SPI_SDO	
4:3		101 ₂	READABLE	SAR_SDO	
		110 ₂	LS_AMP_ENABLE	SAR_SDO	
		1112	GPIO_DATA	SAR_SDO	
	SAR_CH_SEL	be logic high whenever the louds amplifier for stereo loudspeaker a	ill accept digital mic data. GPIO1's beaker amplifier is enabled. This is pplications. channel for the 2nd (Right) I ² S ch	s useful for enabling an extern	
		SAR_CH_SEL	Selected	Channel	
		002	VSA		
		012	VSA	 .R_2	
		102	D_V _{DD} /2 c	pr BB_V _{DD}	
		112	A_V		
5	I2S_MODE	If set the I2S operates in left justified mode (sometimes referred to as DSP mode). See example below. (Note 30)			
		If set the PCM interface uses LONG frame sync which is essentially an inverted short frame sync.			
6	PCM_LONG		If GPIO_SEL is set to GPIO_DATA then the content of this field is passed to GPIO1 as an output.		

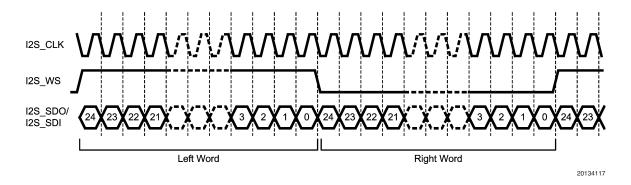


FIGURE 12. I²S Serial Data Format (Left Justified Mode)

12.34 SAR CHANNELS 0 & 1 CONFIGURATION REGISTER

This register is used to control channel 0 and 1 of the SAR system. (Note 31)

TABLE 33. SAR_SLOT01 (0x1Bh)

Bits	Field	De	escription
2:0	SLOT_0_FS	Programs the sampling frequency	of SAR channel 0:
		SLOT_0_FS	Sample Rate @ 12.000 MHz
			(point A)
		0002	13.888 kHz
		0012	3.472 kHz
		0102	0.868 kHz
		0112	217 Hz
		1002	54 Hz
		1012	14 Hz
		1102	4 Hz
		1112	1 Hz
3	SLOT_0_ENB	If set then VSAR 1 is sampled into SAR slot 0 which also	
		SAR ADC.	
6:4	SLOT_1_FS	Programs the sampling frequency	of SAR channel 1:
		SLOT_1_FS	Sample Rate @ 12.000 MHz
			(point A)
		0002	13.888 kHz
		0012	3.472 kHz
		0102	0.868 kHz
		0112	217 Hz
		1002	54 Hz
		1012	14 Hz
		1102	4 Hz
		1112	1 Hz
7	SLOT_1_ENB	If set then VSAR 2 is sampled int SAR ADC.	to SAR slot 1 which also activates the

Note 31: See the section SAR Overview for more details on this register.

12.35 SAR CHANNELS 2 & 3 CONFIGURATION REGISTER

This register is used to control channel 2 and 3 of the SAR system. (Note 31)

Bits	Field	Descr	iption
2:0	SLOT_2_FS	Programs the sampling frequency of S	SAR channels 2 and 3:
		SLOT_2_FS	Sample Rate @ 12.000 MHz
			(point A)
		0002	13.888 kHz
		0012	3.472 kHz
		0102	0.868 kHz
		0112	217 Hz
		1002	54 Hz
		1012	14 Hz
		1102	4 Hz
		1112	1 Hz
3	SLOT_2_ENB	If set then D_V_{DD} / 2 or BB_V_{DD} (depending on SLOT2_V _{BB}) is sampled into SAR slot 2 which also activates the SAR ADC.	
4	SLOT_3_ENB	If set then A_V _{DD} / 2 is sampled into SAR ADC.	SAR slot 3 which also activates the
5	SLOT_2_VBB	If set then BB_V _{DD} input is used as ir D_V _{DD} .	nput to SAR slot 2 rather than the

12.36 SAR DATA 0 TO 3 REGISTERS

These registers are used to read the 8 MSBs from the 4 SAR channels.

TABLE 35. SAR_DATA_0 Register (0x1Dh)

Bits	Field	Description	
7:0	SLOT_0_DATA	Latest slot 0 sample bits 11:4.	

TABLE 36. SAR_DATA_1 Register (0x1Eh)

Bits	Field	Description
7:0	SLOT_1_DATA	Latest slot 1 sample bits 11:4.

TABLE 37. SAR_DATA_2 Register (0x1Fh)

Bits	Field	Description	
7:0	SLOT_2_DATA	Latest slot 2 sample bits 11:4.	

TABLE 38. SAR_DATA_3 Register (0x20h)

Bits	Field	Description
7:0	SLOT_3_DATA	Latest slot 3 sample bits 11:4.

12.37 SAR OVERVIEW

The SAR controller works via a scheduler that allocates time slots for each of the four channels. All four channels can operate up to the same maximum frequency. When the sampling frequency of a channel is to be reduced the time slot allocated to that channel is simply enabled less often. For example if one slot is to work at a quarter of the frequency of the others then only one in four of its allocated slot triggers the SAR to activate:

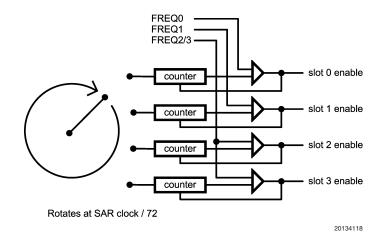


FIGURE 13. Internal SAR Control Signals to SAR Module

Each time slot is used to sample a single fixed input, slot 0 is used for VSAR 1, slot 1 for VSAR 2, slot 2 for either $D_{-}V_{DD}$ or $BB_{-}V_{DD}^{*}$ and slot 3 for the $A_{-}V_{DD}$. When a particular time slot is activated the correct mux, clock and enable controls to the ADC module are produced and the output sampled when ready. If the $D_{-}V_{DD}$ or the $A_{-}V_{DD}$ are being sampled then a voltage divider is used to half the input to below the full scale reference of 2.5V. As this results in a current path to ground it is only inserted while the ADC is settling to reduce power consumption.

Using this method, samples can be taken using as little power as possible while allowing sample rates as low as 1 Hz. The data can either be read directly or used to trigger interrupts when set voltages are passed. This reduces the baseband controllers software overhead and IO bandwidth, further reducing system power.

The full scale digital output from the SAR is equal to 2.5V. The A_V_{DD} and D_V_{DD} inputs are divided by two during sampling. The SAR ADC can be activated at any time, even while the chip is in shutdown mode (chip mode '00'). This allows the LM4935 to perform housekeeping duties such as voltage monitoring with minimal power consumption.

*Depending on SLOT_2_VBB in SAR_SLOT23 (0x1Ch).

12.0 Status & Control Registers (Continued) Only the 8 MSBS [11:4] from the 12 bits of SAR output data can be read back using the I²C interface. The SPI interface can be used to access all 12 bits of the SAR output data. In this case, GPIO2 should be set to SAR_SDO by setting GPIO_SEL in register (0x1Ah). The SAR channel selected by SAR_CH_SEL in the GPIO register is then output onto GPIO2 as follows: TEST_MODE/CS CLK SD GPIO2 11 n SAR Data 20134108 FIGURE 14. SPI SAR Read Transaction (GPIO2 set to SAR_SDO) In applications where the 8 MSBS [11:4] from the SAR output data is enough resolution, GPIO2 should be set to SPI_SDO by setting GPIO_SEL in register (0x1Ah). The SAR data is then output on GPIO2 as follows: TEST MODE/CS CLK Ignored SDI 14 GPIO2 Address SAR Data 20134107 FIGURE 15. SPI SAR Read Transaction (GPIO2 set to SPI_SDO) If the user performs a write to the GPIO register the changes will not take effect until the next SPI operation so SAR data can be read while the next channel is being selected. The SAR data is sampled at the start of the SPI transaction to ensure that the data is stable during the read operation. All 12 bits of the SAR output data for up to 2 SAR channels can be read back simultaneously through the bi-directional I2S interface. This is accomplished by setting I2S_SDO_DATA (bit [7:6] of (0x19h)) to the desired SAR channel(s). As mentioned previously in the Digital Audio Data Formats section, when SAR SDO is passed to the I²S bus, the SAR SDO's MSB is aligned with the MSB of I2S SDO.

LM4935

12.38 DC VOLUME CONFIGURATION REGISTER

This register is used to control the DC volume control system.

TABLE 39. DC_VOLUME (0x21h)

Bits	Field	Description		
0	DC_VOL_ENB	Enables the DC volume control system	Enables the DC volume control system to use the voltage applied on the	
		VSAR 1 pin to set the gain of the DC	VSAR 1 pin to set the gain of the DC volume control. (Note 32)	
1	DC_VOL_EFFECT	Selects which volume is altered:		
		DC_VOL_EFFECT	Source	
		0	AUX/DAC	
		1	CPI	
3:2	MAX_LEVEL	Programs the maximum level that can	be applied by the system	
		MAX_LEVEL	LEVEL	
		002	0 dB	
		012	–3 dB	
		102	-6 dB	
		112	–12 dB	

Note 32: The correlation between the voltage on VSAR1 to the attenuation on the AUX/DAC channel is as follows:

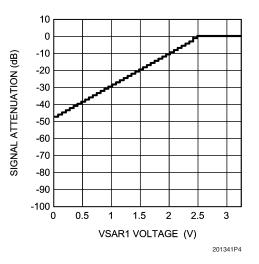


FIGURE 16. DC Volume Transfer Function For AUX/DAC

LM4935

12.39 SAR TRIGGER 1 CONFIGURATION REGISTER

This register is used to setup a voltage trigger on one of the SAR outputs.

TABLE 40. TRIG_1 (0x22h)

Bits	Field	Description	
0	TRIG_1_ENB	Enables the 1st SAR trigger interrupt,	if cleared will clear the IRQ.
1	TRIG_1_DIR	Selects the direction the voltage should	Id be moving:
		TRIG_1_DIR	Trigger if signal passes:
		0	Above Threshold
		1	Below Threshold
3:2	TRIG_1_SOURCE	Programs the channel used by the trigger.	
		TRIG_1_SOURCE	Source
		002	VSAR_1
		012	VSAR_2
		102	$D_V_{DD}/2$ or BB_V_{DD}
		112	A_V _{DD} /2
7:4	TRIG_1_LSB	Sets bits 3:0 of the threshold used by	the trigger.

12.40 SAR TRIGGER 1 MSBs CONFIGURATION REGISTER

This register is used to setup the threshold of a voltage trigger on one of the SAR outputs.

TABLE 41. TRIG_1_MSB (0x23h)

7:0 TRIG_1_MSB Sets bits 11:4 of the threshold used by the trigger.	Bits	Field	Description
	7:0	TRIG_1_MSB	Sets bits 11:4 of the threshold used by the trigger.

12.41 SAR TRIGGER 2 CONFIGURATION REGISTER

This register is used to setup a voltage trigger on one of the SAR outputs.

TABLE 42. TRIG_2 (0x24h)

Bits	Field	Desc	Description	
0	TRIG_2_ENB	Enables the 2nd SAR trigger interrupt	t, if cleared will clear the IRQ.	
1	TRIG_2_DIR	Selects the direction the voltage should	Ild be moving:	
		TRIG_2_DIR	Trigger if signal passes:	
		0	Above Threshold	
		1	Below Threshold	
3:2	TRIG_2_SOURCE	Programs the channel used by the trigger		
		TRIG_2_SOURCE	Source	
		002	VSAR_1	
		012	VSAR_2	
		102	$D_V_{DD}/2$ or BB_V_{DD}	
		112	A_V _{DD} /2	
7:4	TRIG_2_LSB	Sets bits 3:0 of the threshold used by	the trigger.	

12.42 SAR TRIGGER 2 MSBs CONFIGURATION REGISTER

This register is used to setup the threshold of a voltage trigger on one of the SAR outputs.

TABLE 43. TRIG_2_MSB (0x25h)

Bits	Field	Description
7:0	TRIG_2_MSB	Sets bits 11:4 of the threshold used by the trigger.
		*

12.43 DEBUG REGISTER

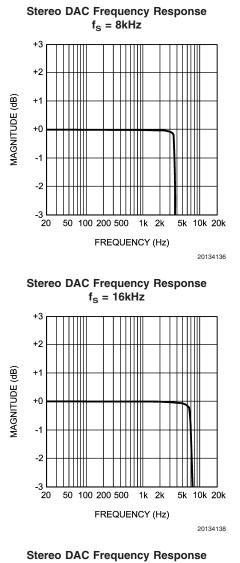
This register is used to set test modes within the device.

TABLE 44. DEBUG (0x26h)

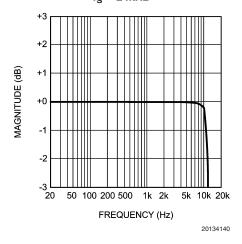
Bits	Field	Description			
0	RSVD	Reserved			
1	RSVD	Reserved			
2	RSVD	Reserved	Reserved		
3	SOFT_RESET	This field can be used to reset t	This field can be used to reset the chip without a power cycle.		
4	RSVD	Reserved			
5	RSVD	Reserved			
6	RSVD	Reserved			
7	GPIO_TEST_MODE	If set and GPIO_SEL = '010', then the GPIOs are configured to interface with the LMV1026			
		digital microphone as long as AUDIO_IF_MODE (0x19h) is not set to '11'.			
		GPIO_SEL	GPIO 1	GPIO 2	
		0002	RSVD	RSVD	
		0012	RSVD	RSVD	
		0102	VADC_CLOCK_OUT	DIG_MIC_IN	
		0112	RSVD	RSVD	
		1002	RSVD	RSVD	
		1012	RSVD	RSVD	
		1102	RSVD	RSVD	
		111 ₂	RSVD	RSVD	

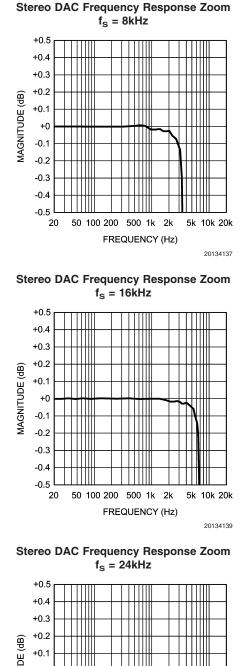
13.0 Typical Performance Characteristics

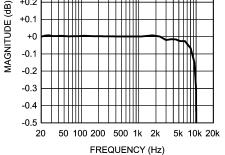
(For all performance curves AV_{DD} refers to the voltage applied to the A_V_{DD} and LS_V_{DD} pins. DV_{DD} refers to the voltage applied to the D_V_{DD} and PLL_V_{DD} pins; $AV_{DD} = 3.3V$ and $DV_{DD} = 3.3V$ unless otherwise specified.



f_s = 24kHz



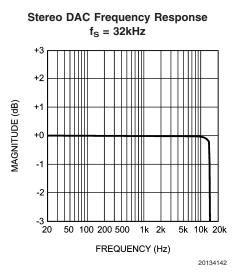


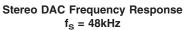


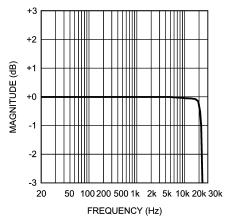
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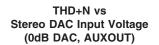
13.0 Typical Performance Characteristics (Continued)

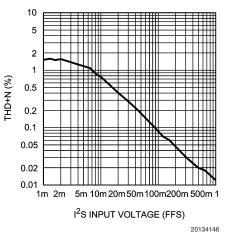


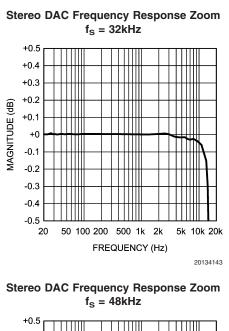


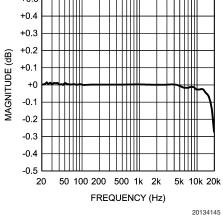


20134144

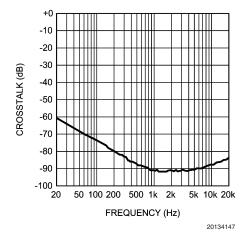


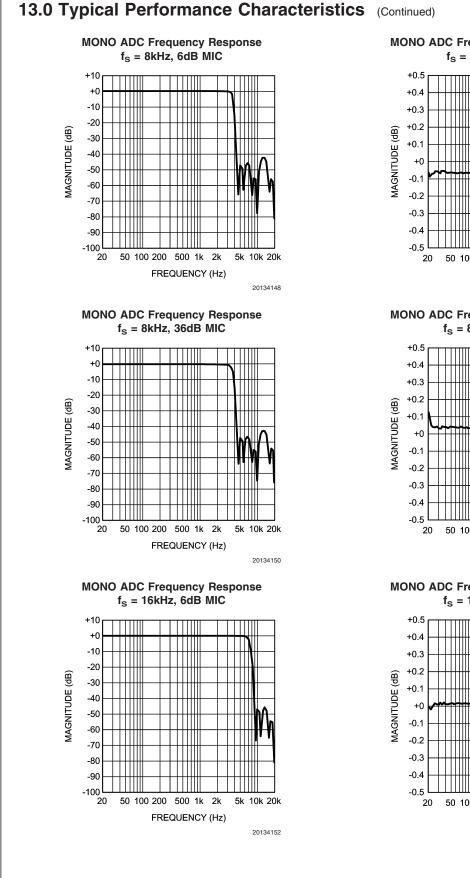


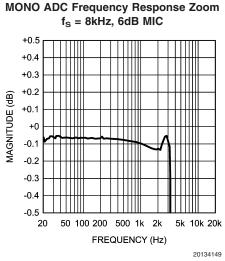




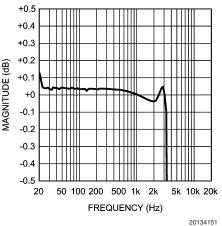
Stereo DAC Crosstalk (0dB DAC, HP SE)



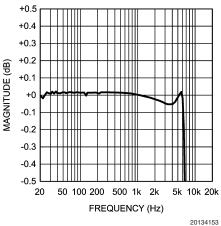




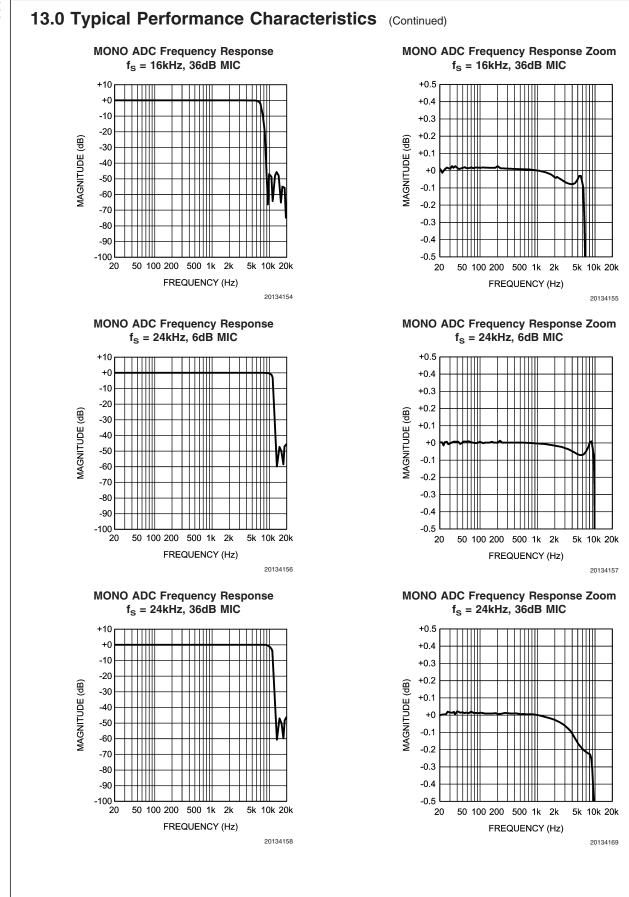
MONO ADC Frequency Response Zoom f_s = 8kHz, 36dB MIC



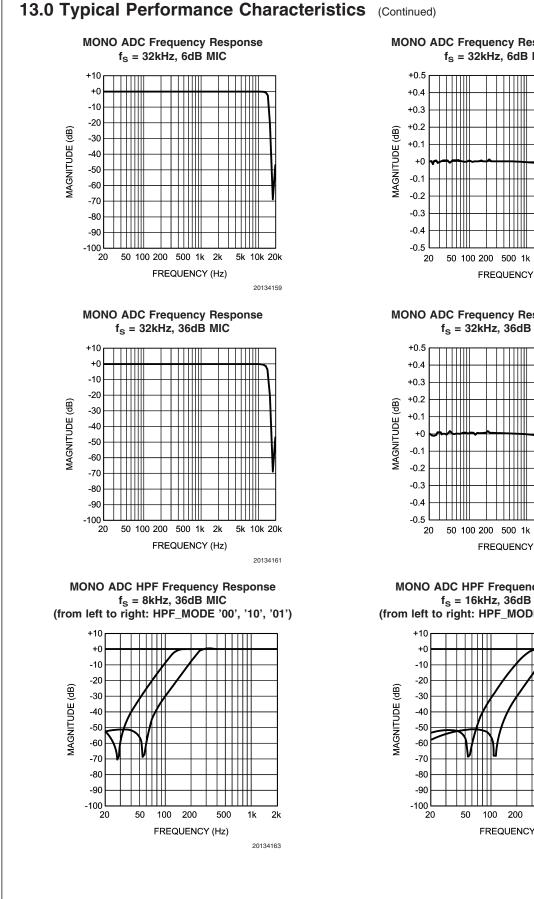
MONO ADC Frequency Response Zoom f_s = 16kHz, 6dB MIC

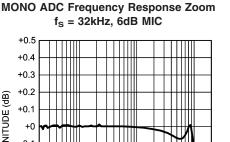


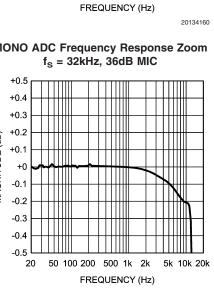
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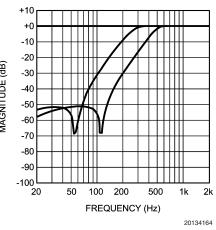








MONO ADC HPF Frequency Response $f_s = 16$ kHz, 36dB MIC (from left to right: HPF_MODE '00', '10', '01')



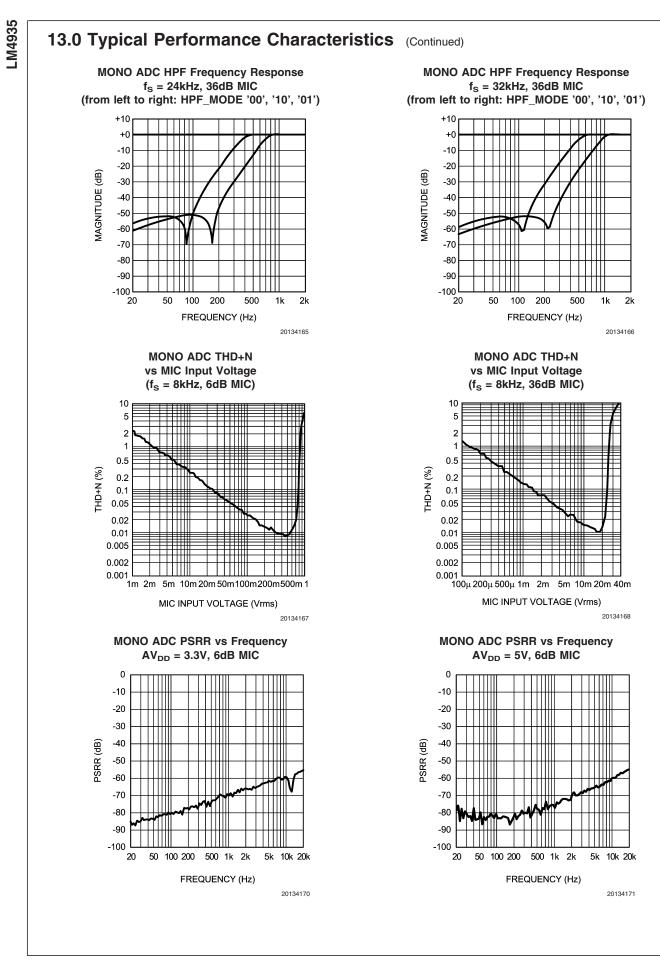
2k

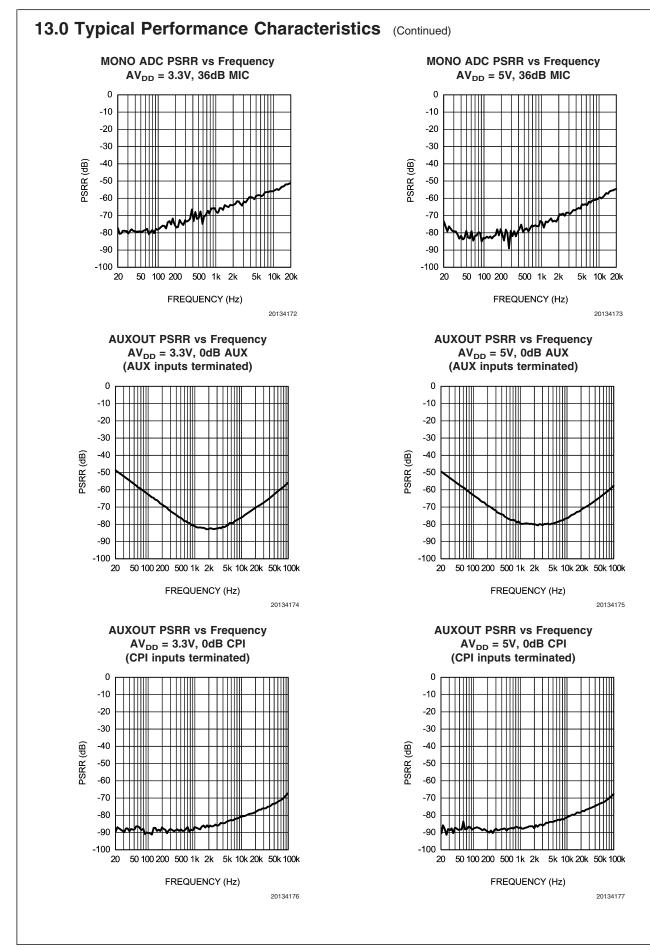
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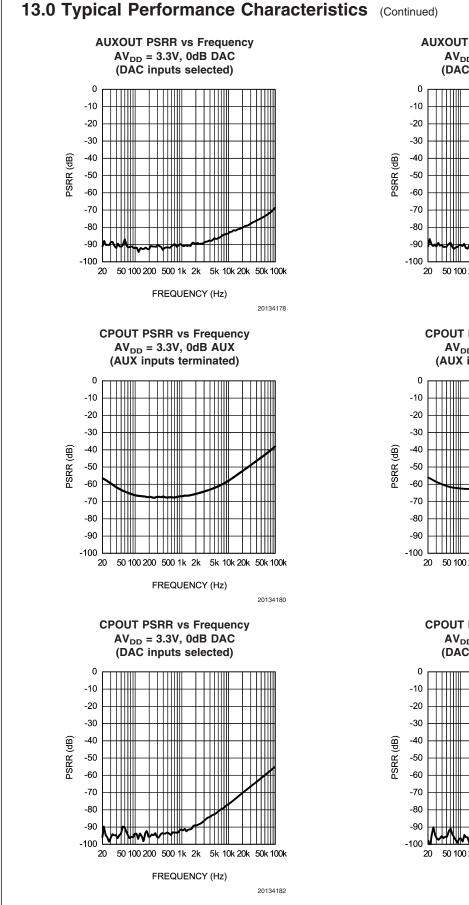
5k 10k 20k

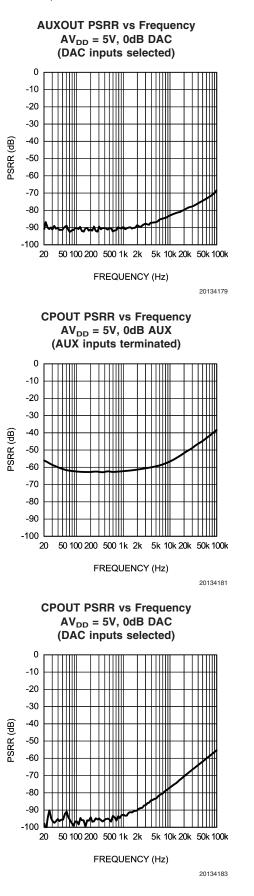
MONO ADC Frequency Response Zoom

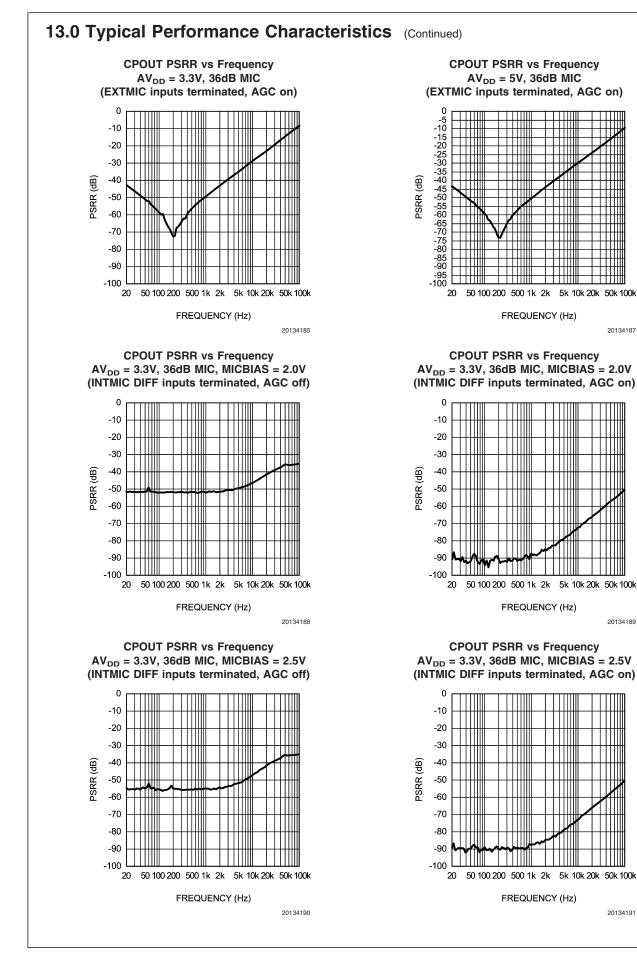
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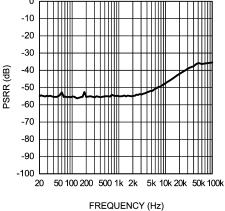




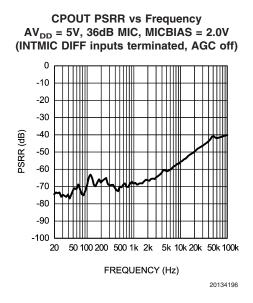


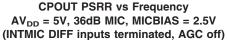
13.0 Typical Performance Characteristics (Continued)

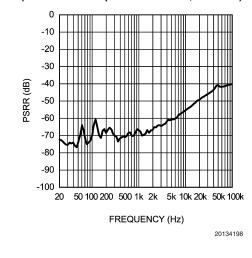
CPOUT PSRR vs Frequency AV_{DD} = 3.3V, 36dB MIC, MICBIAS = 2.8V (INTMIC DIFF inputs terminated, AGC off)

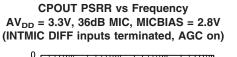


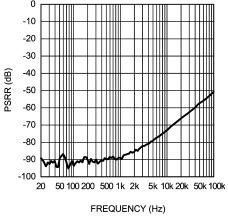
20134192





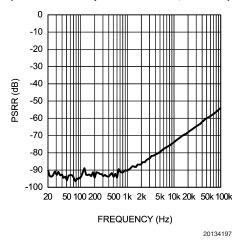




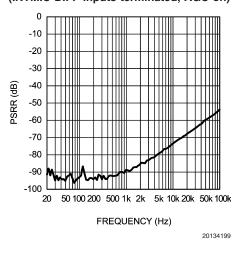


20134193

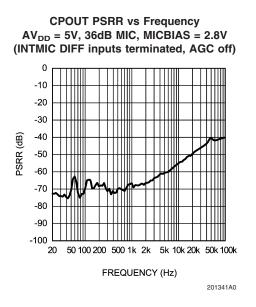
CPOUT PSRR vs Frequency AV_{DD} = 5V, 36dB MIC, MICBIAS = 2.0V (INTMIC DIFF inputs terminated, AGC on)



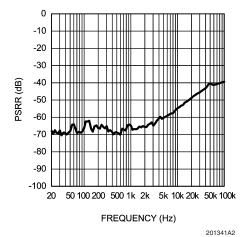
CPOUT PSRR vs Frequency $AV_{DD} = 5V$, 36dB MIC, MICBIAS = 2.5V (INTMIC DIFF inputs terminated, AGC on)



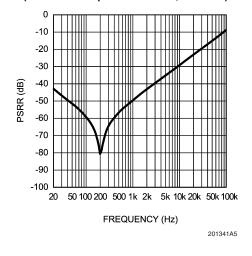
13.0 Typical Performance Characteristics (Continued)



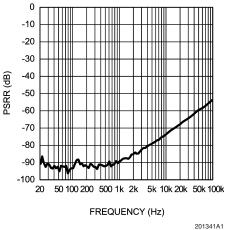
CPOUT PSRR vs Frequency AV_{DD} = 5V, 36dB MIC, MICBIAS = 3.3V (INTMIC DIFF inputs terminated, AGC off)

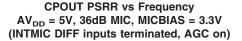


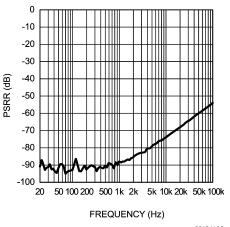




CPOUT PSRR vs Frequency $AV_{DD} = 5V, 36dB MIC, MICBIAS = 2.8V$ (INTMIC DIFF inputs terminated, AGC on)

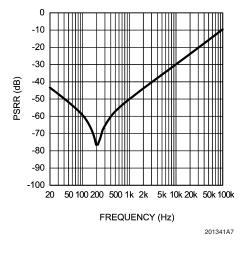


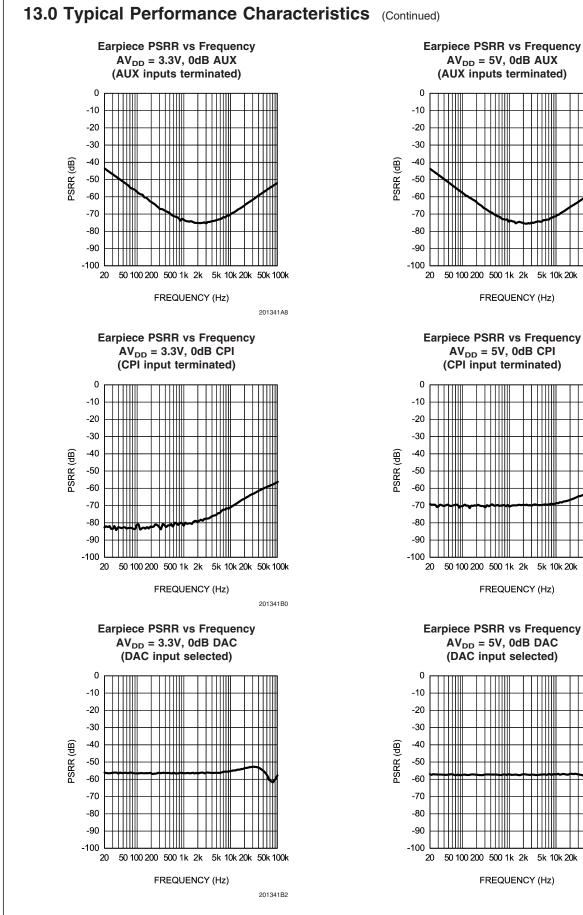


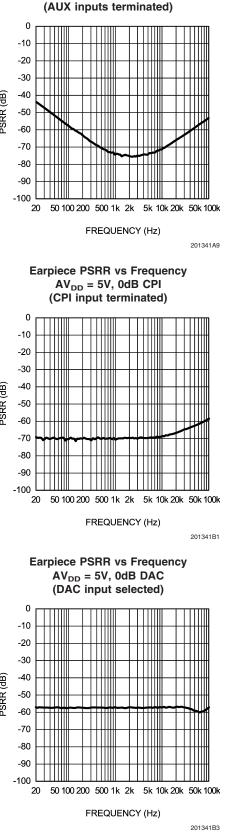


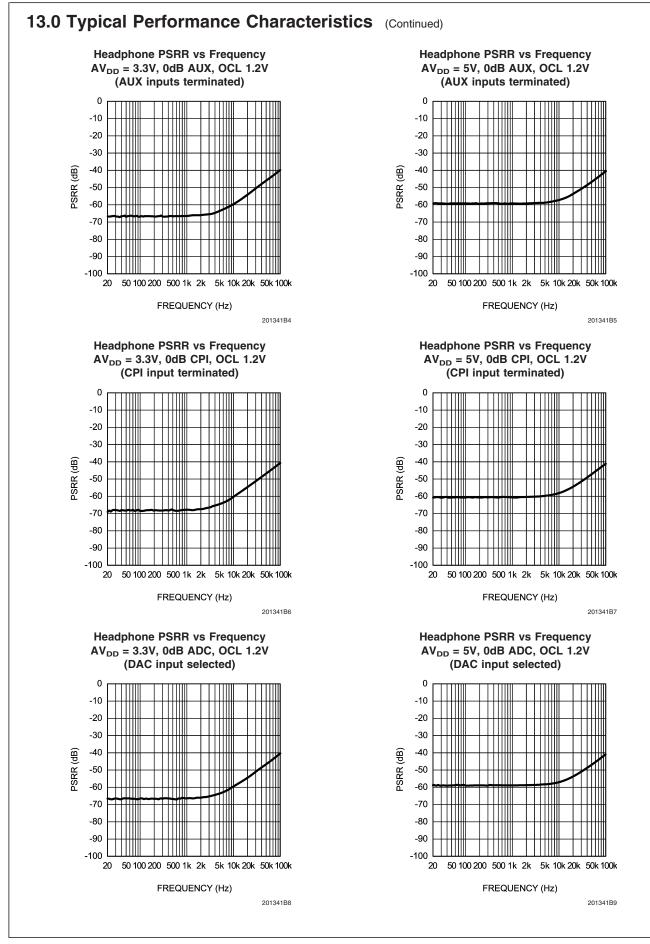
201341A3

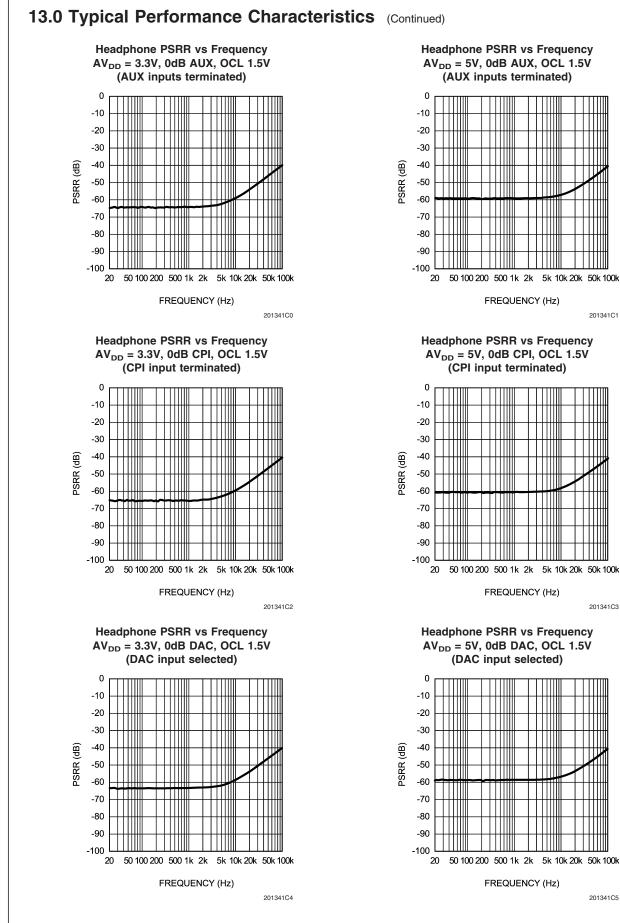










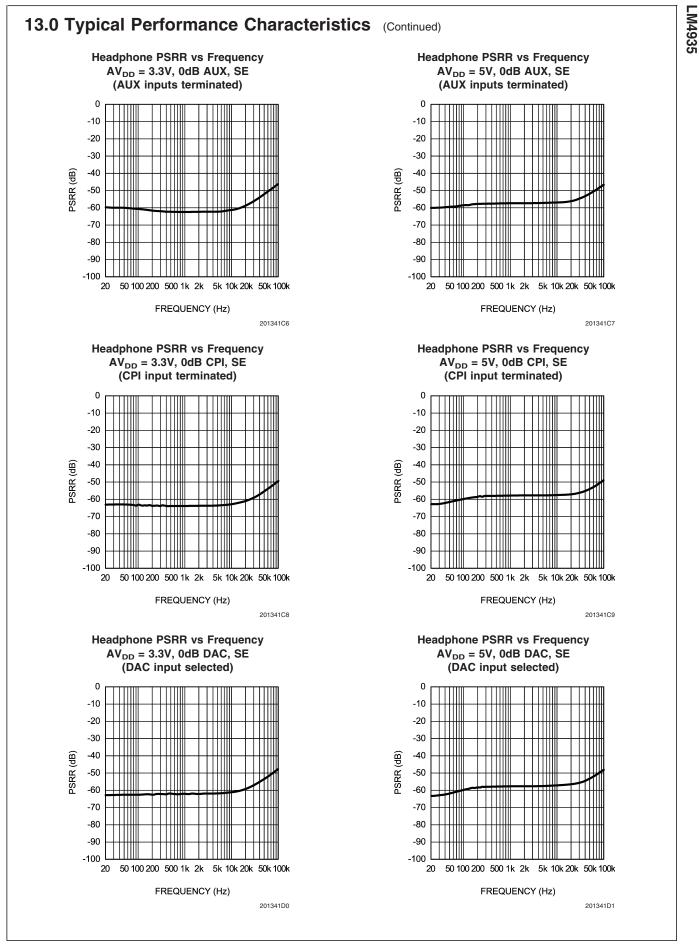


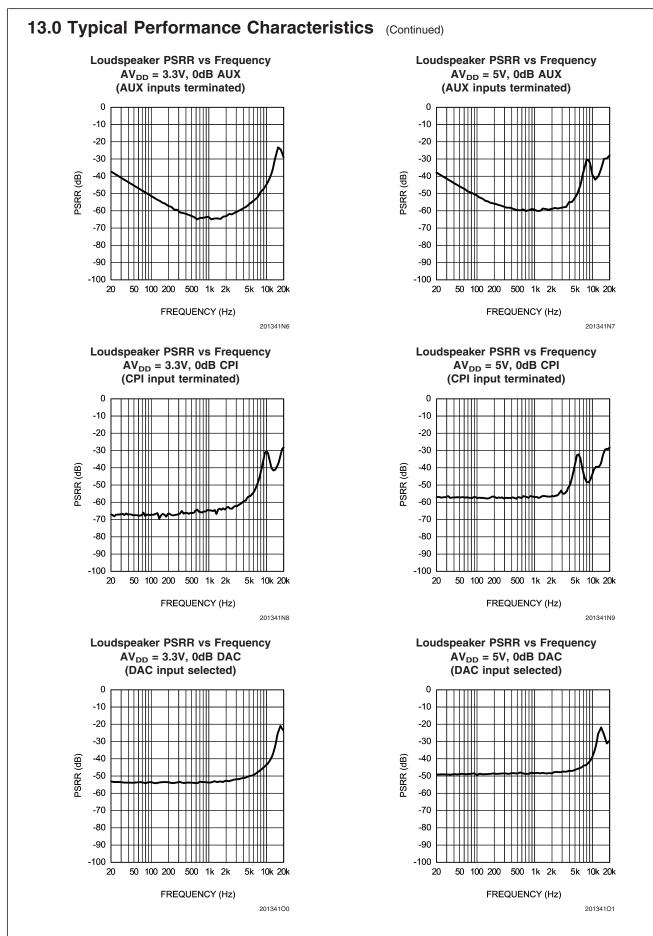
201341C1

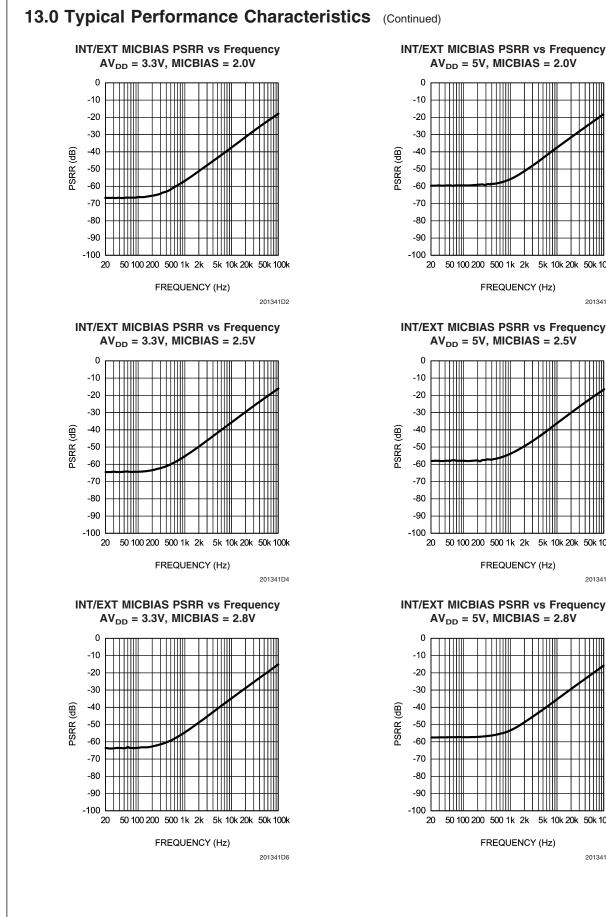
201341C3

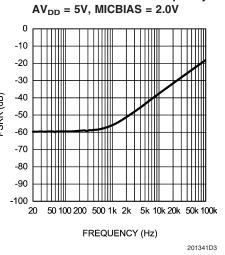
201341C5



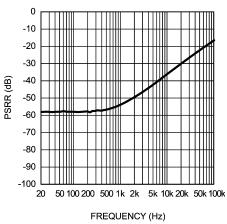






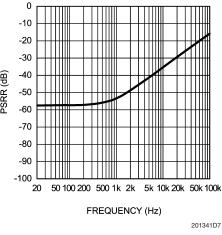


INT/EXT MICBIAS PSRR vs Frequency $AV_{DD} = 5V, MICBIAS = 2.5V$

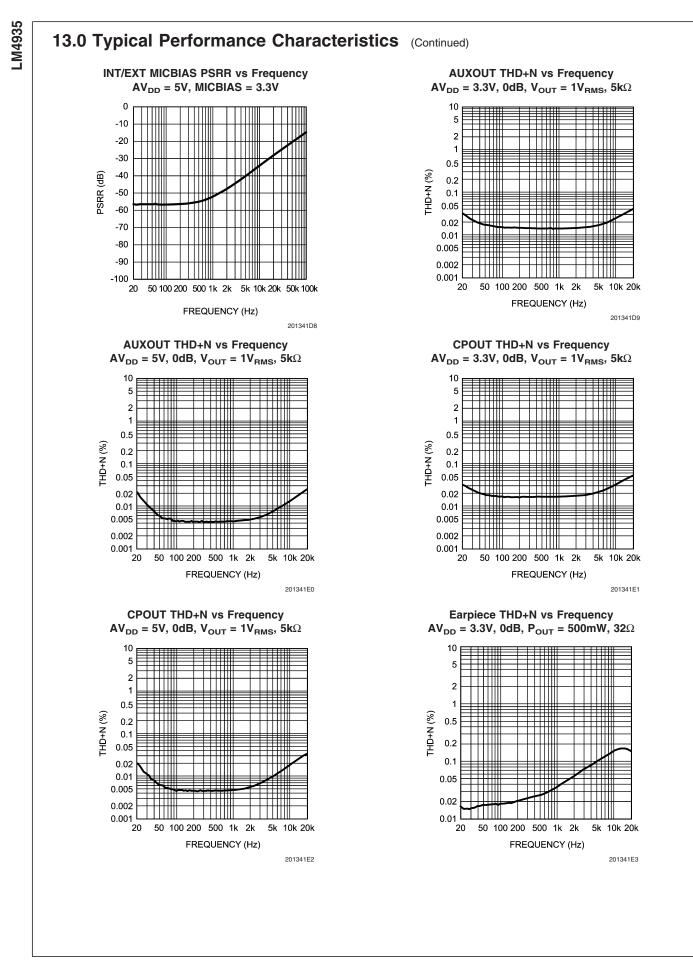


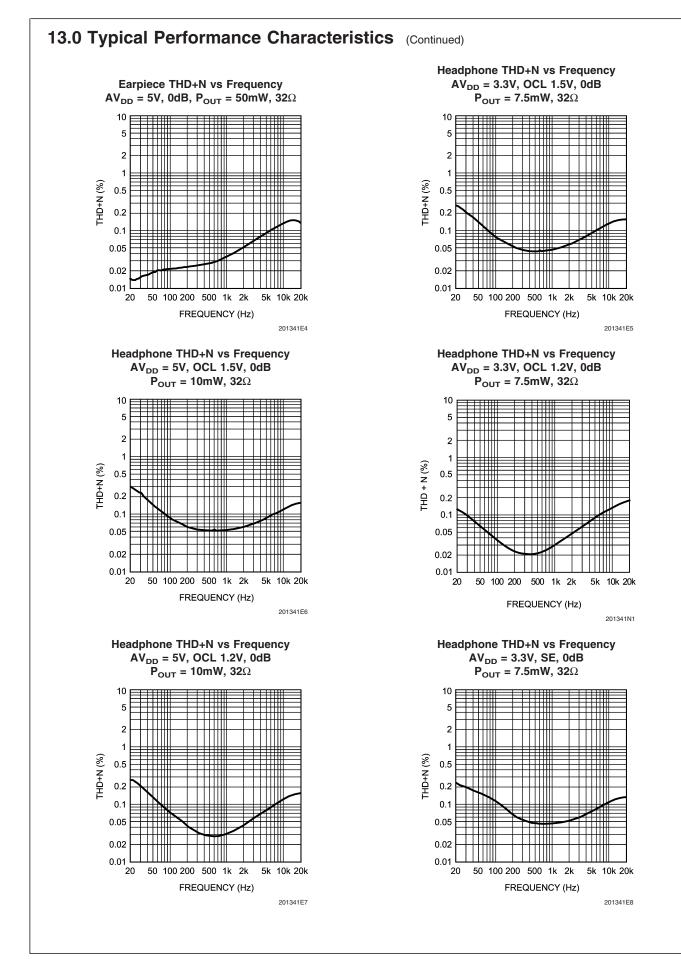
201341D5

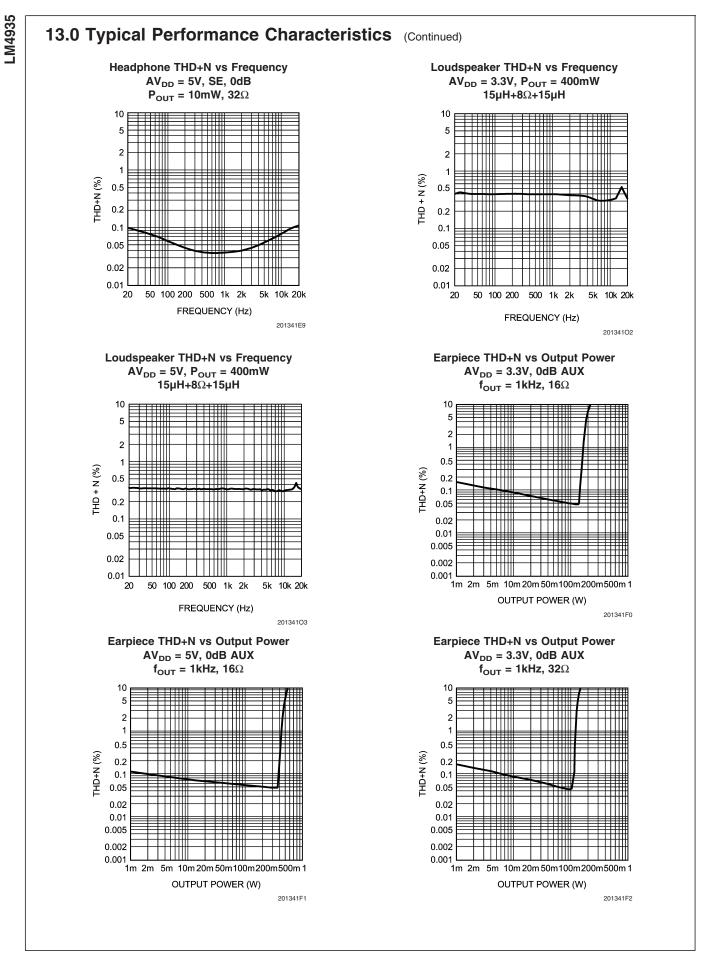
INT/EXT MICBIAS PSRR vs Frequency $AV_{DD} = 5V, MICBIAS = 2.8V$

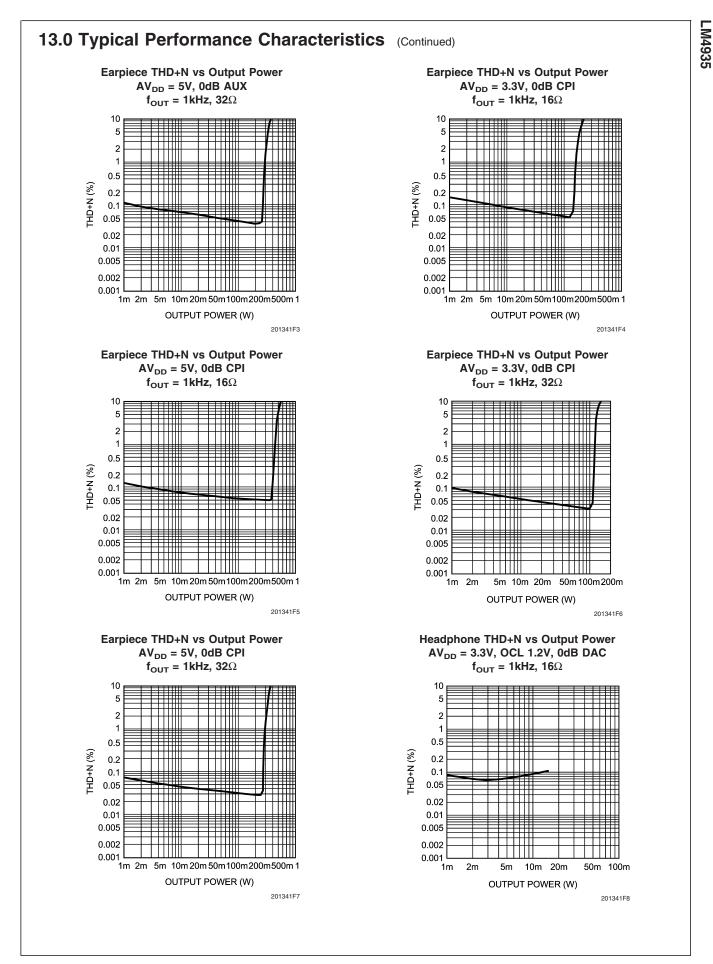


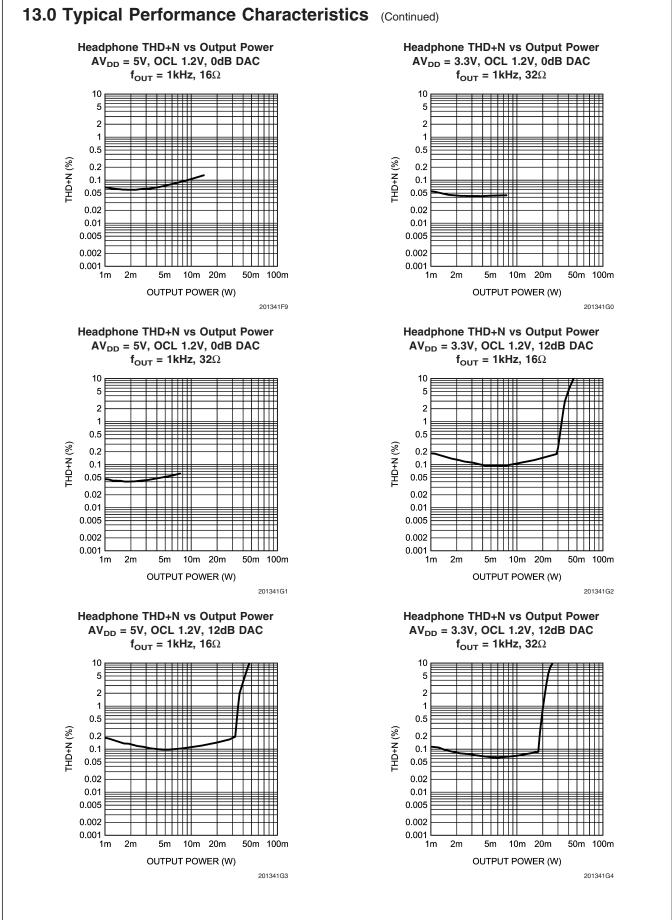
LM4935



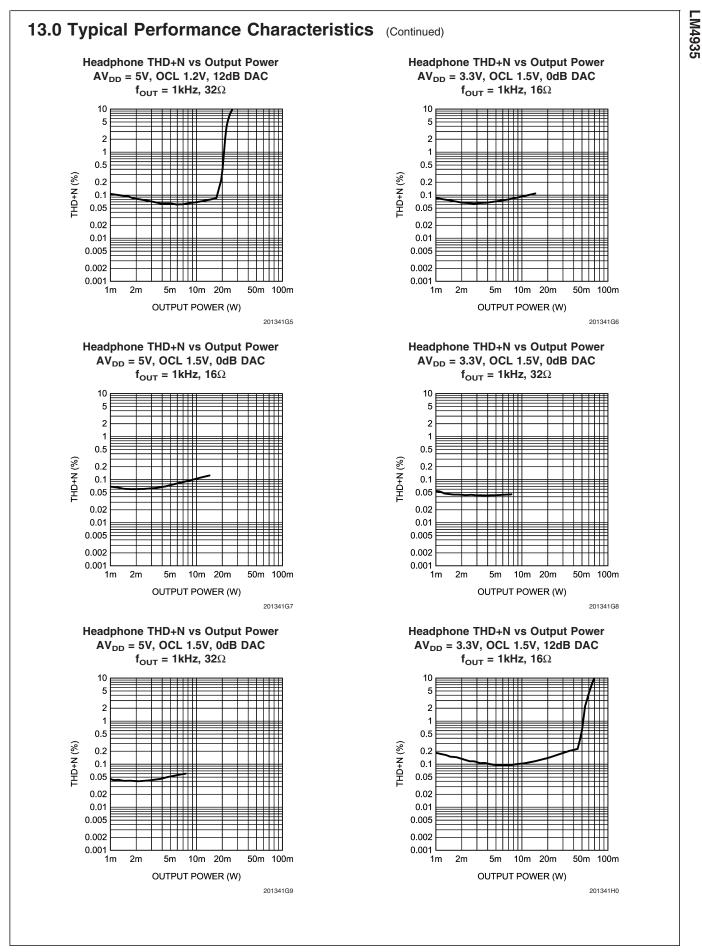


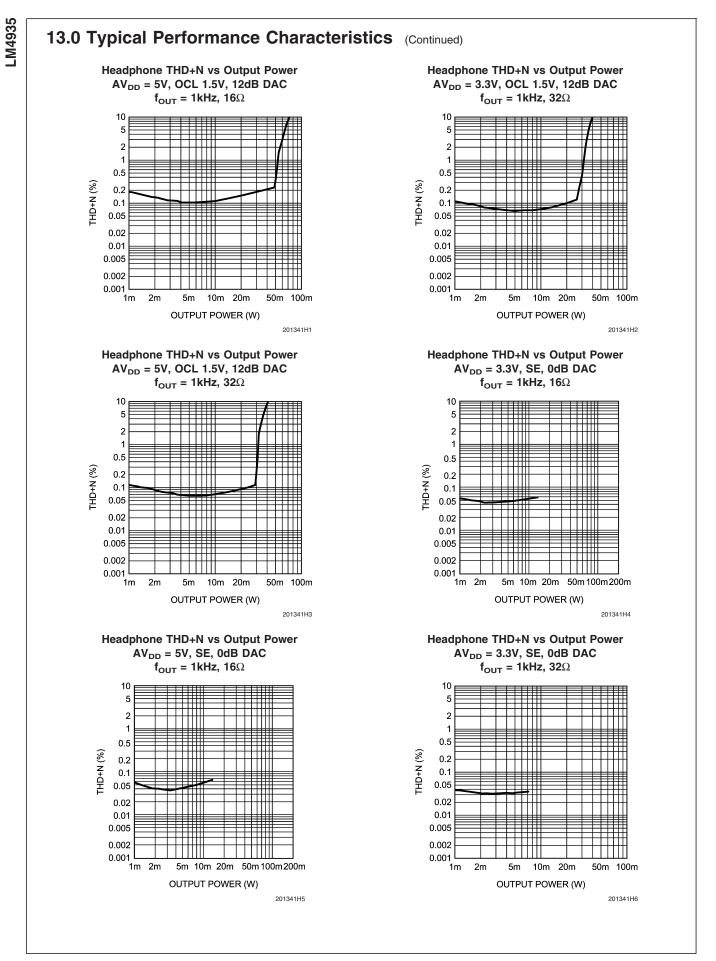


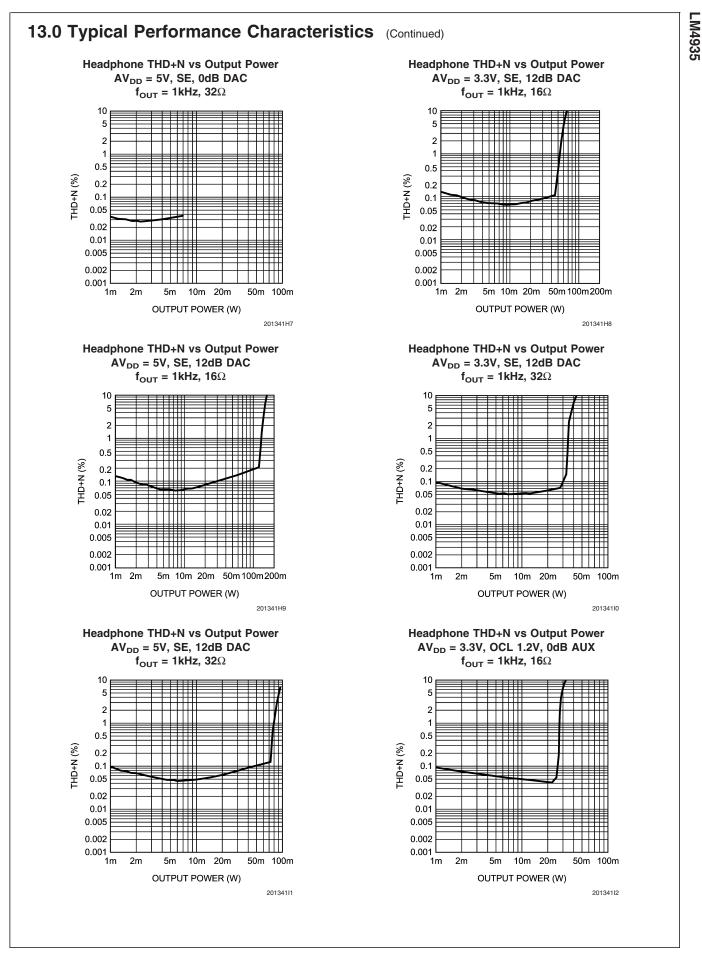


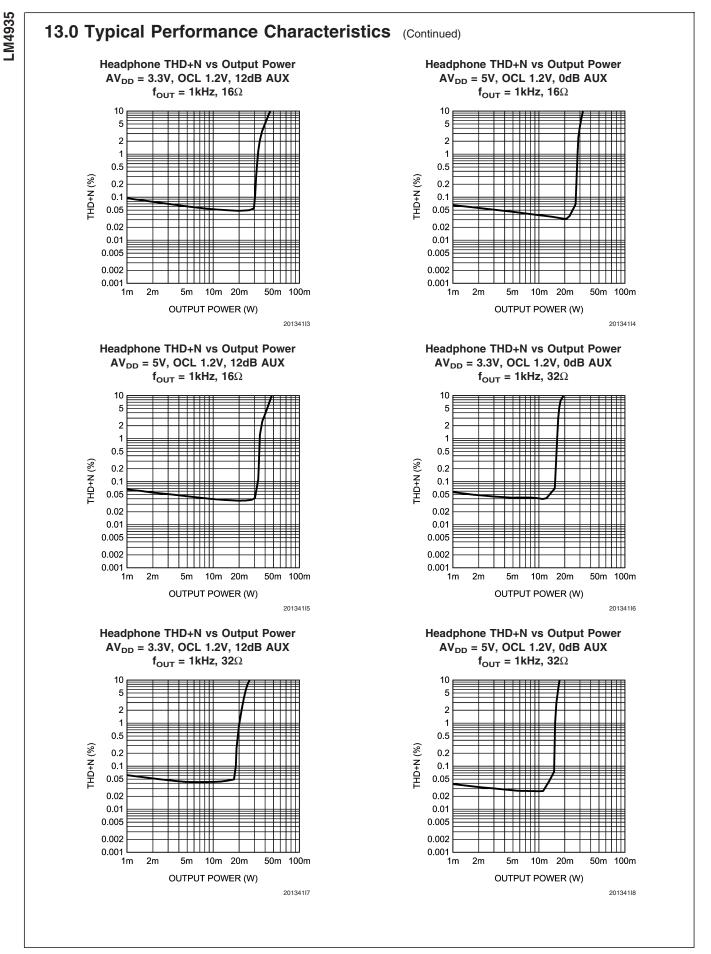


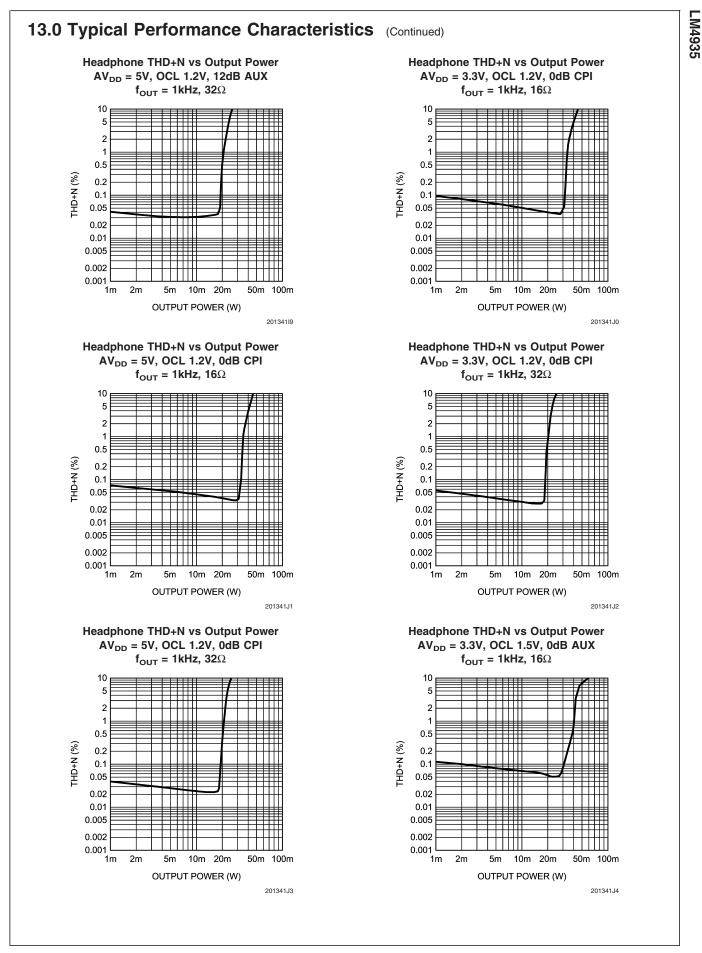


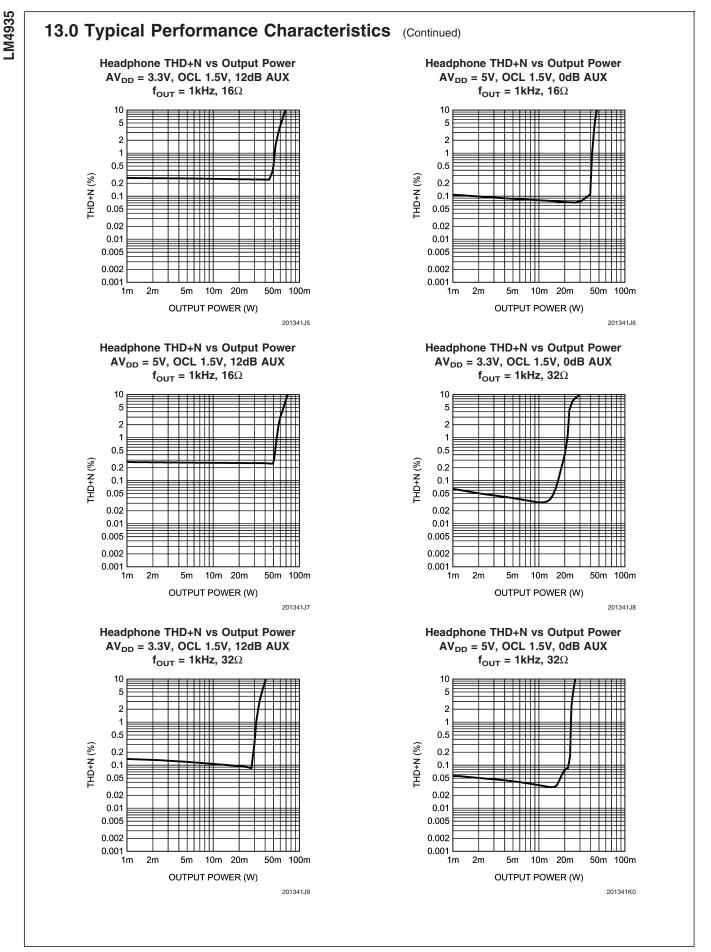


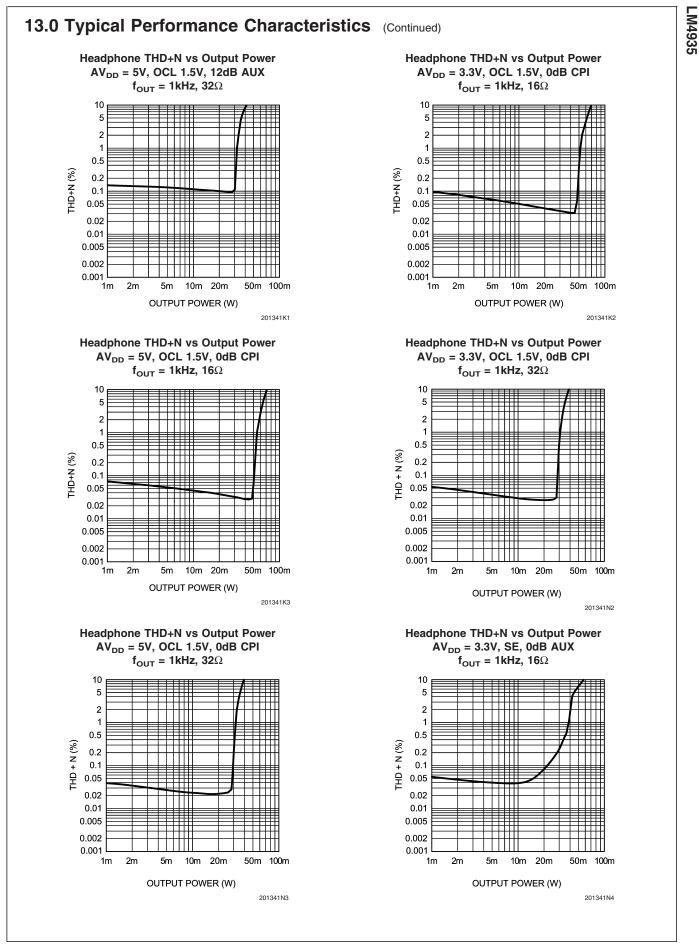


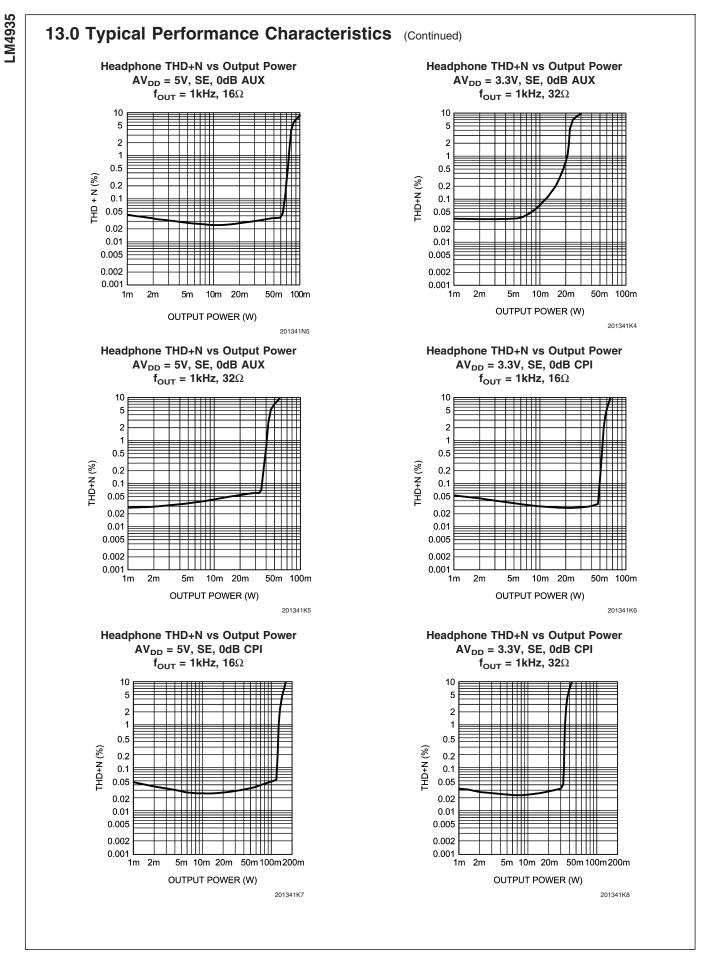


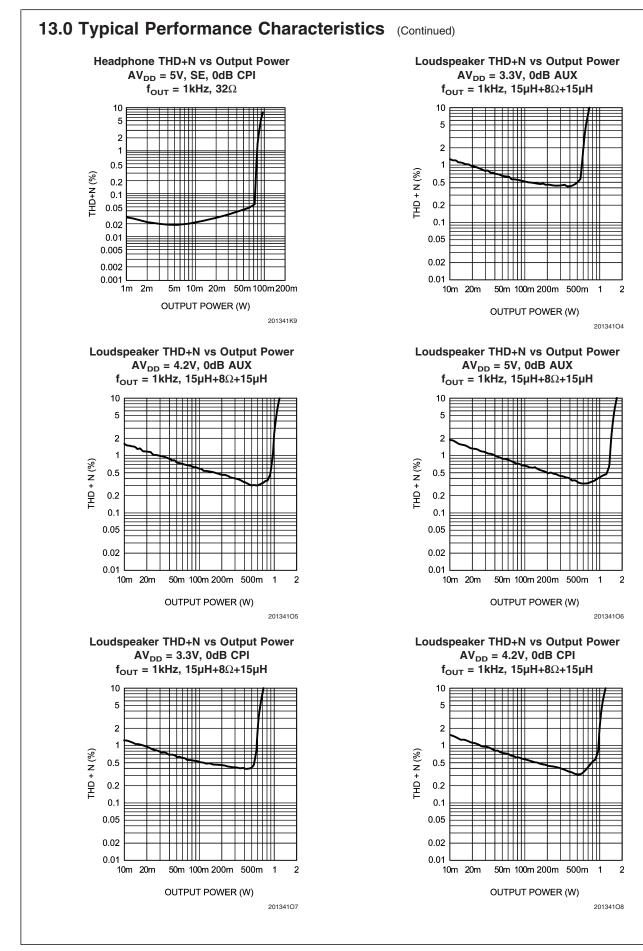


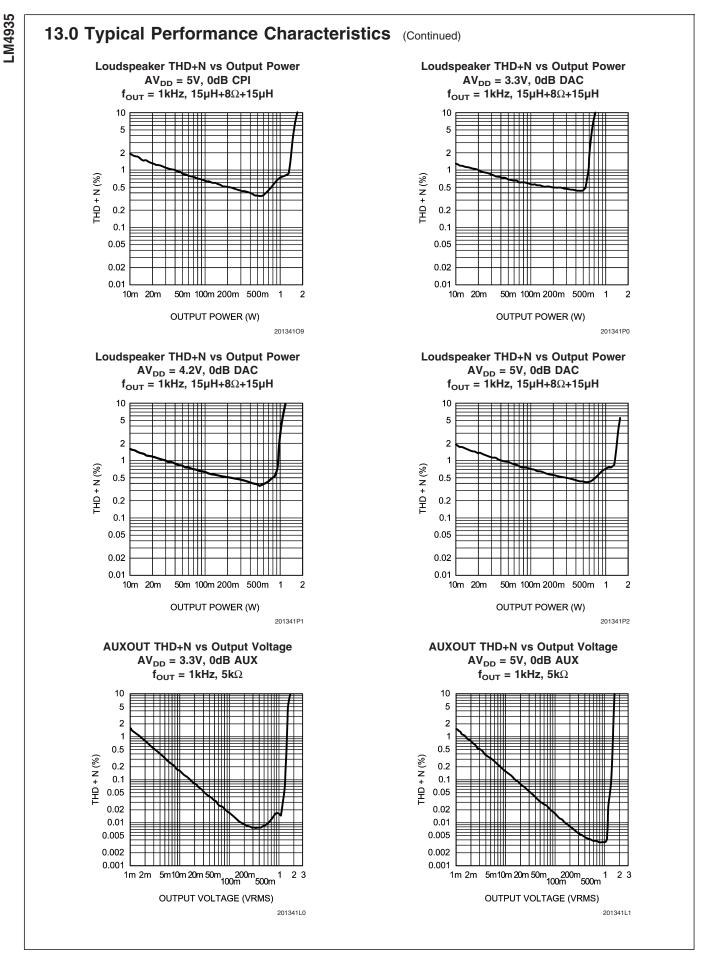


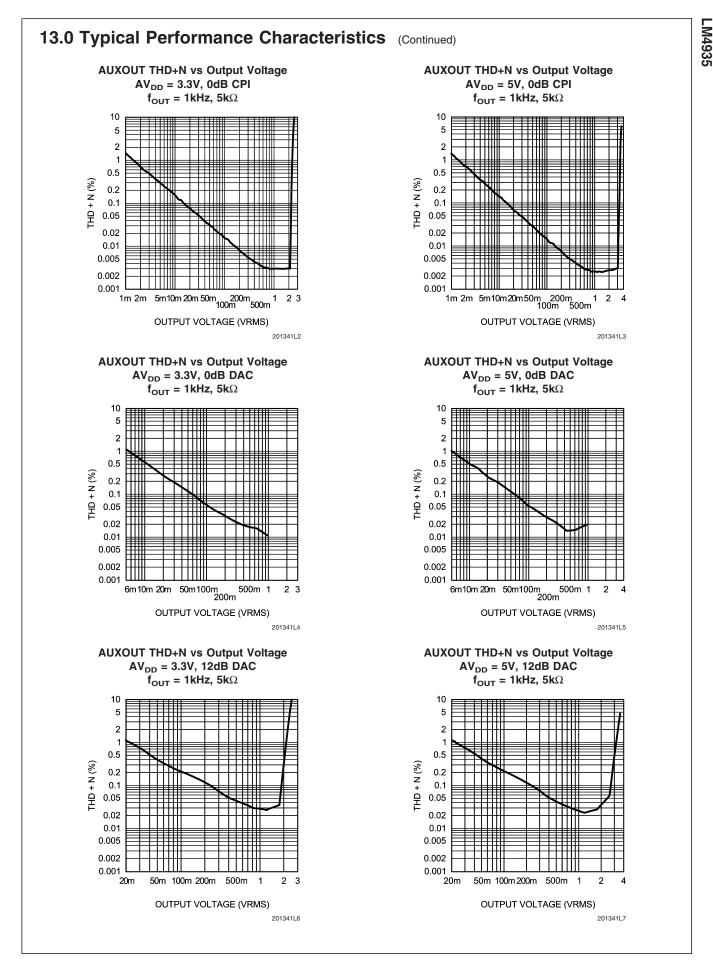


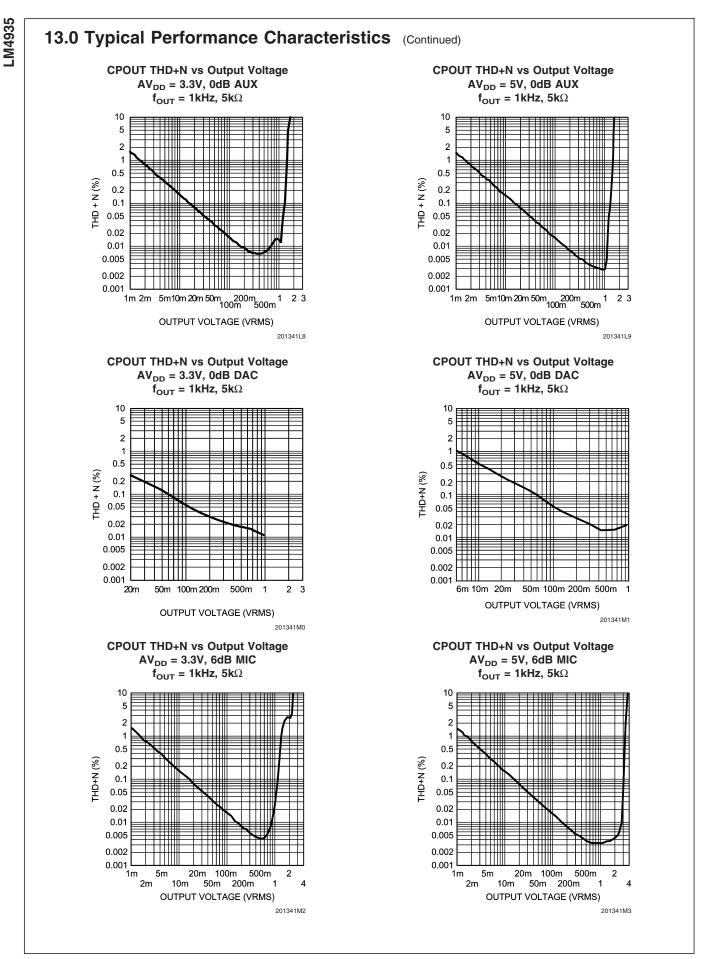


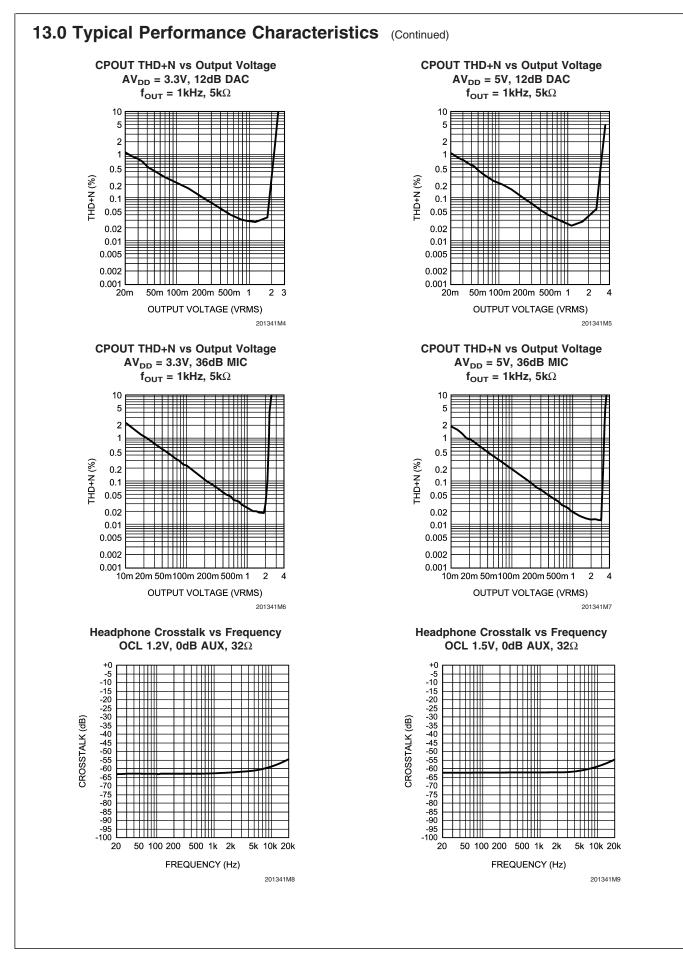


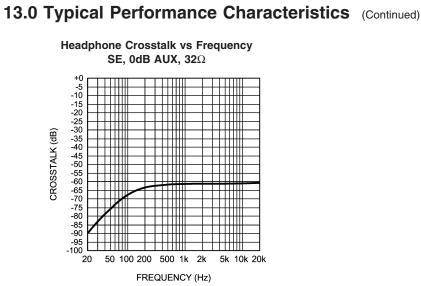




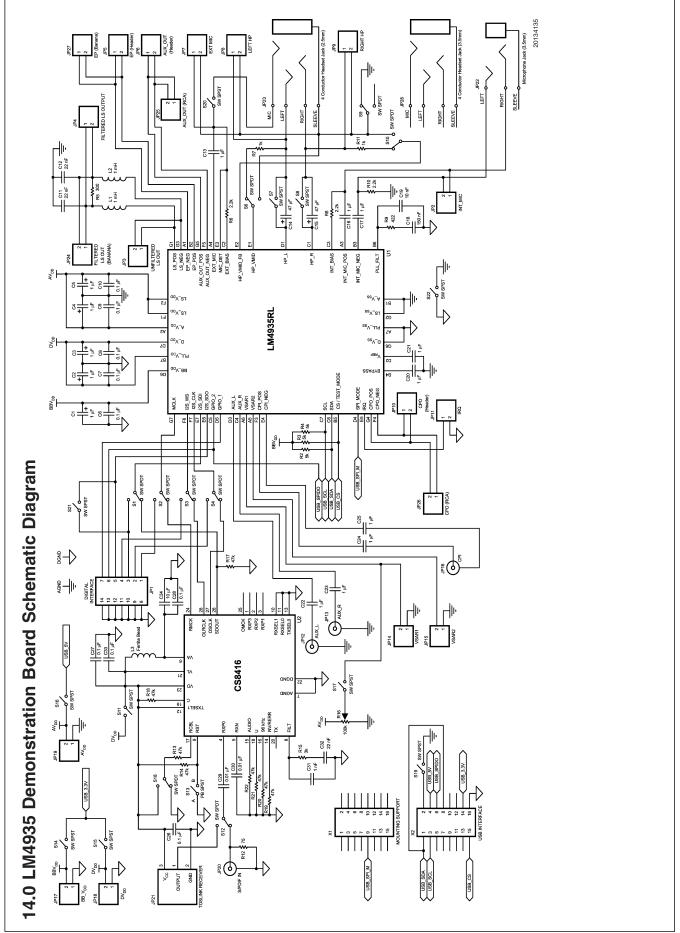




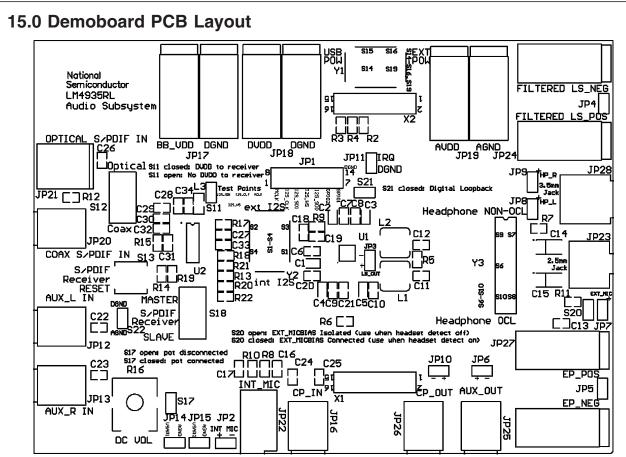




201341N0

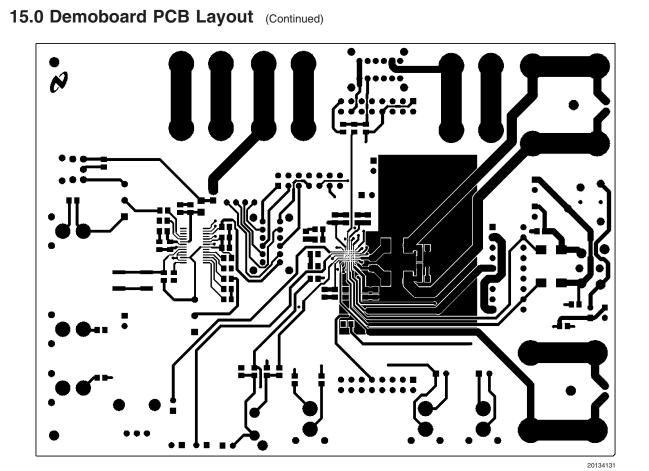






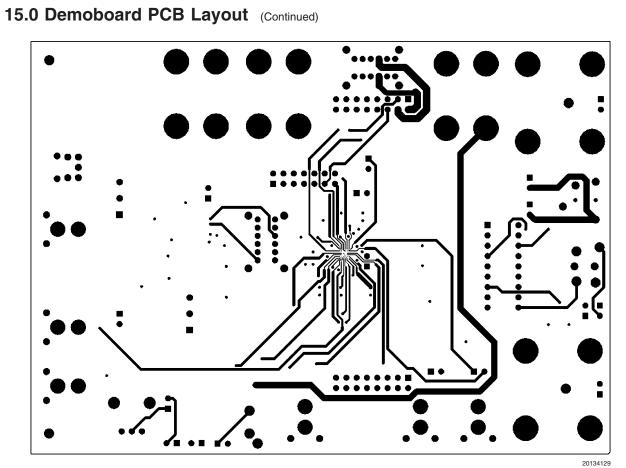
Top Silkscreen

20134132

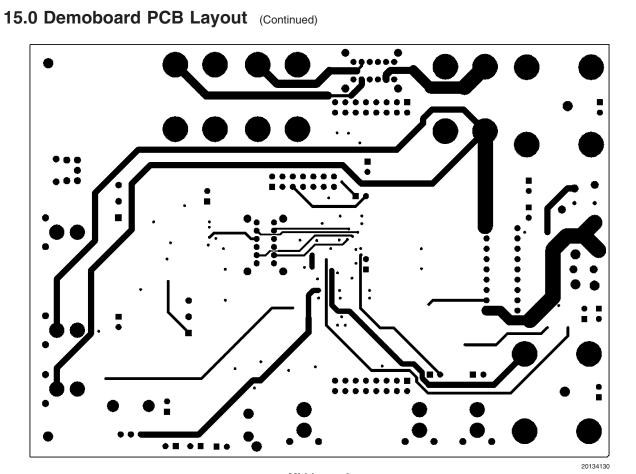


Top Layer



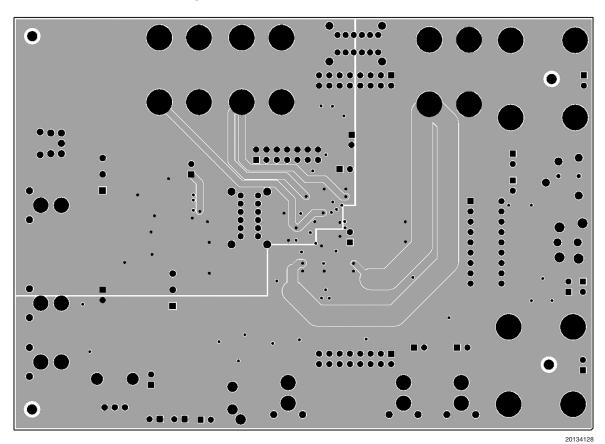


Mid Layer 1



Mid Layer 2

15.0 Demoboard PCB Layout (Continued)



Bottom Layer

16.0 Product Status Definitions

Datasheet Status	Product Status	Definition	
Advance	Formative or in	This data sheet contains the design specifications for product development.	
Information	Design	Specifications may change in any manner without notice.	
Preliminary	First Production	This data sheet contains preliminary data. Supplementary data will be published	
		at a later date. National Semiconductor Corporation reserves the right to make	
		changes at any time without notice in order to improve design and supply the	
		best possible product.	
No Identification	Full Production	This data sheet contains final specifications. National Semiconductor Corporation	
Noted		reserves the right to make changes at any time without notice in order to improve	
		design and supply the best possible product.	
Obsolete	Not in Production	This data sheet contains specifications on a product that has been discontinued	
		by National Semiconductor Corporation. The datasheet is printed for reference	
		information only.	

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17.0 Revision History

Rev	Date	Description
1.0	5/11/05	Filled in the actual limits (for TBDs) under Limit and edited few Typical values, all under the EC table. Edits from Alvin F.
1.1	7/29/05	Input more edits. Replaced the correct boards. Replaced the Schematic Diagram (pg 60).
1.2	9/8/05	Added the 1st set of Typ Perf curves.
1.3	9/21/05	Added a couple of tables.
1.4	9/30/05	Input text edits.
1.5	10/5/05	Input more edits.
1.6	10/11/05	More edits.
1.7	10/12/05	First D/S WEB release.
1.8	10/14/5	Input more text edits after the 1st released.
1.9	10/17/05	Input some text edits, then re-released D/S to the WEB.
2.0	10/18/05	More text edits. Also used graphic 20134107 back.
2.1	12/19/05	Added the RL package
2.2	12/20/05	Deleted the WL pkg and replaced with the RL pkg.
2.3	1/19/06	Fixed 20134132(top silkscreen) and 35 (schem layout) plus few text edits.
2.4	1/25/06	Fixed the value on X3 (mktg outline). Re-released D/S to the WEB.

